

●●●●● Combining Performance, Density, and Embedded RAM

Device Highlights

Flexible Programmable Logic

- 0.25 μm five layer metal CMOS Process
- 2.5 V V_{CC} , 2.5 V/3.3 V Drive Capable I/O
- 1,536 Logic Cells
- 320,640 Max System Gates
- Up to 310 I/O Pins

Embedded Dual Port SRAM

- Twenty-four 2,304-bit Dual Port High Performance SRAM Blocks
- 55,300 RAM bits
- RAM/ROM/FIFO Wizard for Automatic Configuration
- Configurable and Cascadable

Programmable I/O

- High performance Enhanced I/O (EIO)—less than 3 ns T_{CO}
- Programmable Slew Rate Control
- Programmable I/O Standards:
 - LVTTTL, LVCMOS, PCI, GTL+, SSTL2, and SSTL3
 - Eight Independent I/O Banks
 - Three Register Configurations: Input, Output, and Output Enable

Advanced Clock Network

- Nine Global Clock Networks:
 - One Dedicated
 - Eight Programmable
- 20 Quad-Net Networks—five per Quadrant
- 16 I/O Controls—two per I/O Bank
- Four phase locked loops

Embedded Computational Units

ECUs provide integrated Multiply, Add, and Accumulate Functions.

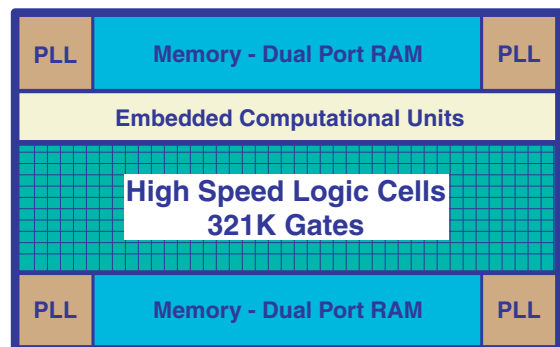


Figure 1: EclipsePlus Block Diagram

Electrical Specifications

AC Characteristics*

*(at $V_{CC} = 2.5\text{ V}$, $T_A = 25^\circ\text{ C}$, Typical Corner, Speed Grade = -7 (K = 1.00))

The AC Specifications are provided from **Table 1** to **Table 9**. Logic Cell diagrams and waveforms are provided from **Figure 2** to **Figure 15**.

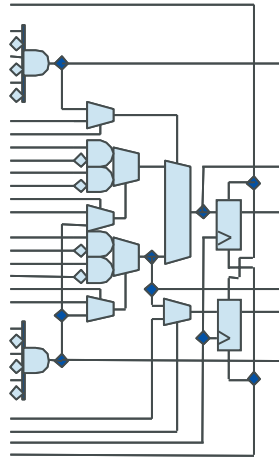


Figure 2: EclipsePlus Logic Cell

Table 1: Logic Cells

| Symbol Logic Cells | Parameter | Value (ns) | |
|-----------------------|---|------------|-------|
| | | Min | Max |
| t_{PD} | Combinatorial Delay of the longest path: time taken by the combinatorial circuit to output | 0.205 | 1.01 |
| t_{SU} | Setup time: time the synchronous input of the flip flop must be stable before the active clock edge | 0.231 | - |
| t_{HL} | Hold time: time the synchronous input of the flip flop must be stable after the active clock edge | 0 | - |
| t_{CO} | Clock to out delay: the amount of time taken by the flip flop to output after the active clock edge. | - | 0.427 |
| t_{CWHI} | Clock High Time: required minimum time the clock stays high | 0.46 | - |
| t_{CWLO} | Clock Low Time: required minimum time that the clock stays low | 0.46 | - |
| t_{SET} | Set Delay: time between when the flip flop is "set" (high) and when the output is consequently "set" (high) | - | 0.585 |
| t_{RESET} | Reset Delay: time between when the flip flop is "reset" (low) and when the output is consequently "reset" (low) | - | 0.658 |
| t_{SW} | Set Width: time that the SET signal remains high/low | 0.3 | - |
| t_{RW} | Reset Width: time that the RESET signal remains high/low | 0.3 | - |

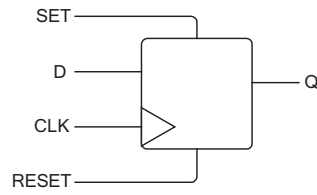


Figure 3: Logic Cell Flip-Flop

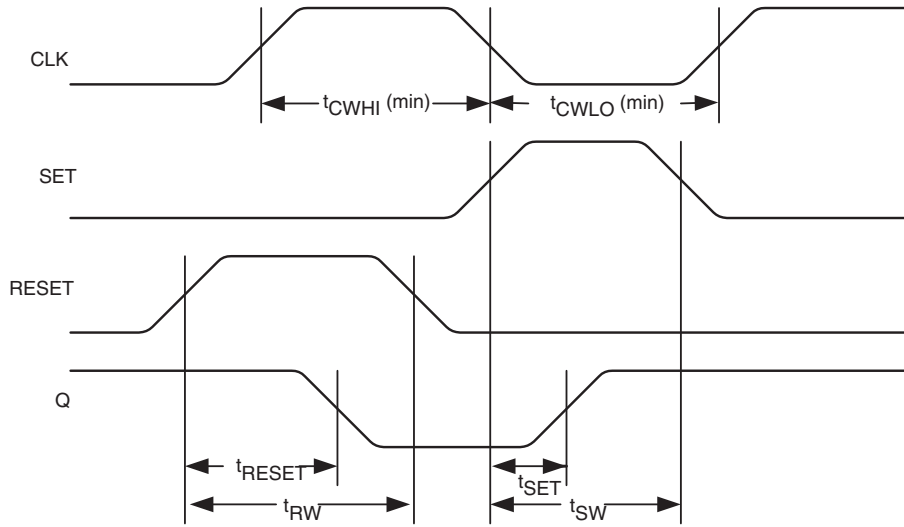


Figure 4: Logic Cell Flip-Flop Timings—First Waveform

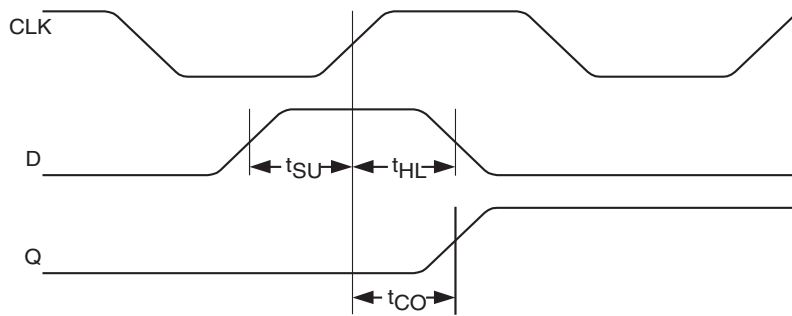


Figure 5: Logic Cell Flip-Flop Timings—Second Waveform

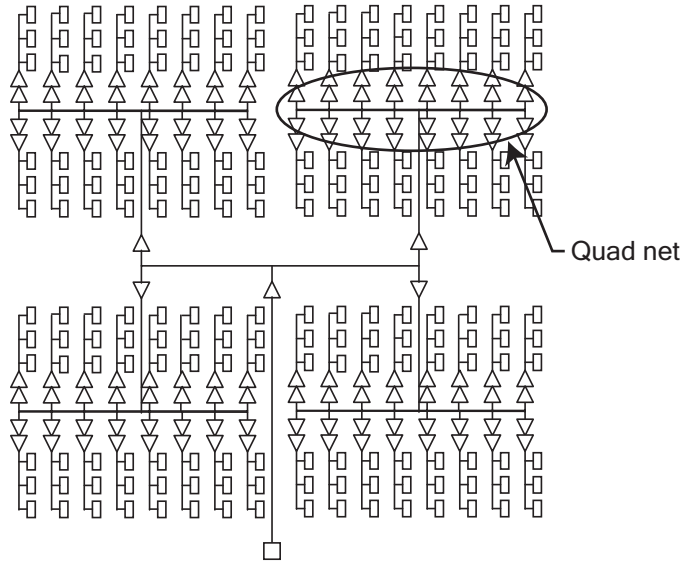


Figure 6: EclipsePlus Global Clock Structure

Table 2: Eclipse Global Clock Tree Delays

| Clock Segment | Parameter | Value (ns) | |
|---------------|---|------------|-----------|
| | | Max. Rise | Max. Fall |
| t_{PGCK} | Global clock pin delay to quad net | 0.990 | 1.386 |
| t_{BGCK} | Global clock buffer delay (quad net to flip flop) | 0.534 | 1.865 |

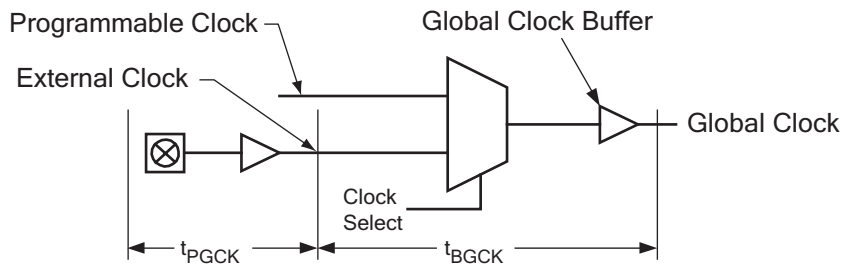


Figure 7: Global Clock Structure Schematic

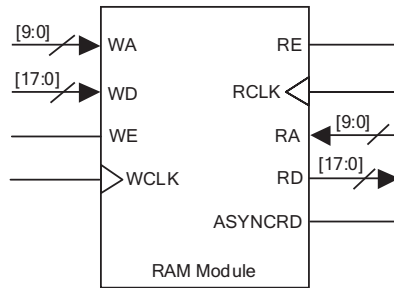


Figure 8: RAM Module

Table 3: RAM Cell Synchronous Write Timing

| Symbol | Parameter | Value (ns) | |
|--|--|------------|----------|
| | | Min | Max |
| RAM Cell Synchronous Write Timing | | | |
| t_{SWA} | WA setup time to WCLK: time the WRITE ADDRESS must be stable before the active edge of the WRITE CLOCK | 0.675 ns | - |
| t_{HWA} | WA hold time to WCLK: time the WRITE ADDRESS must be stable after the active edge of the WRITE CLOCK | 0 ns | - |
| t_{SWD} | WD setup time to WCLK: time the WRITE DATA must be stable before the active edge of the WRITE CLOCK | 0.654 ns | - |
| t_{HWD} | WD hold time to WCLK: time the WRITE DATA must be stable after the active edge of the WRITE CLOCK | 0 ns | - |
| t_{SWE} | WE setup time to WCLK: time the WRITE ENABLE must be stable before the active edge of the WRITE CLOCK | 0.276 ns | - |
| t_{HWE} | WE hold time to WCLK: time the WRITE ENABLE must be stable after the active edge of the WRITE CLOCK | 0 ns | - |
| t_{WCRD} | WCLK to RD (WA = RA): time between the active WRITE CLOCK edge and the time when the data is available at RD | - | 2.796 ns |

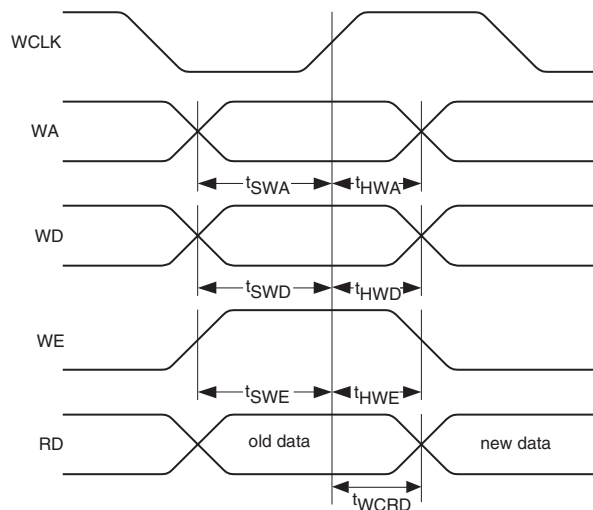


Figure 9: RAM Cell Synchronous Write Timing

Table 4: RAM Cell Synchronous & Asynchronous Read Timing

| Symbol | RAM Cell Synchronous Read Timing Parameter | Value (ns) | |
|-----------------------------------|--|------------|----------|
| | | Min | Max |
| t_{SRA} | RA setup time to RCLK: time the READ ADDRESS must be stable before the active edge of the READ CLOCK | 0.686 ns | - |
| t_{HRA} | RA hold time to RCLK: time the READ ADDRESS must be stable after the active edge of the READ CLOCK | 0 ns | - |
| t_{SRE} | RE setup time to WCLK: time the READ ENABLE must be stable before the active edge of the READ CLOCK | 0.243 ns | - |
| t_{HRE} | RE hold time to WCLK: time the READ ENABLE must be stable after the active edge of the READ CLOCK | 0 ns | - |
| t_{RCD} | RCLK to RD: time between the active READ CLOCK edge and the time when the data is available at RD | - | 2.225 ns |
| RAM Cell Asynchronous Read Timing | | | |
| t_{PDRD} | RA to RD: time between when the READ ADDRESS is input and when the DATA is output | - | 2.405 ns |

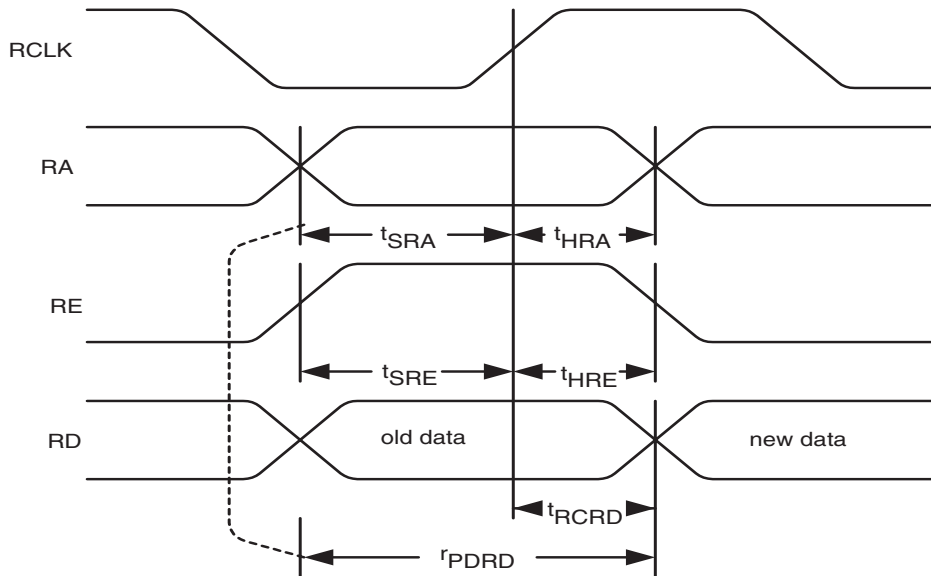


Figure 10: RAM Cell Synchronous & Asynchronous Read Timing

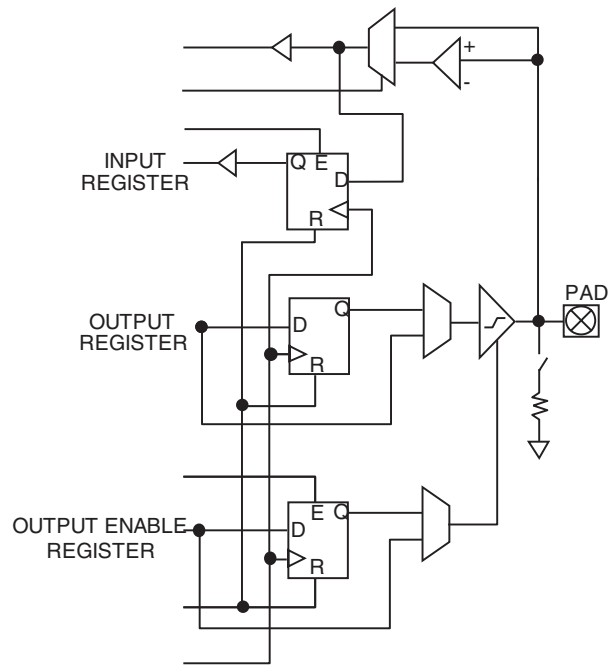


Figure 11: EclipsePlus Cell I/O

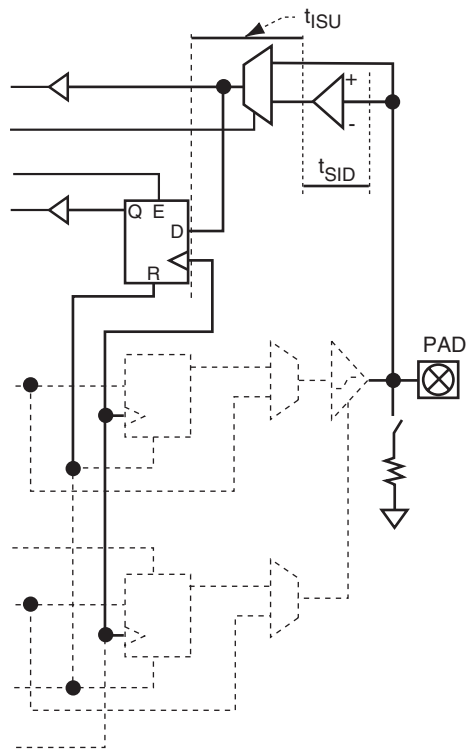


Figure 12: EclipsePlus Input Register Cell

Table 5: Input Register Cell

| Symbol | Parameter: Input Register Cell Only | Value (ns) | |
|------------|---|------------|----------|
| | | Min | Max |
| t_{ISU} | Input register setup time: the time the synchronous input of the pin must be stable before the active clock edge | 3.308 ns | 3.526 ns |
| t_{IHL} | Input register hold time: the time the synchronous input of the flip-flop must be stable after the active clock edge | 0 ns | - |
| t_{ICO} | Input register clock-to-out: the time taken by the flip-flop to output after the active clock edge | - | 0.494 ns |
| t_{IRST} | Input register reset delay: the time between when the flip-flop is “reset”(low) and when the output is consequently “reset” (low) | - | 0.464 ns |
| t_{IESU} | Input register clock enable setup time: the time “enable” must be stable before the active clock edge | 0.830 ns | 0.987 ns |
| t_{IEH} | Input register clock enable hold time: the time “enable” must be stable after the active clock edge | 0 ns | - |

Table 6: Standard Input Delays

| Symbol | Parameter | Value | |
|---------------------|--|-------|---------|
| | | Min | Max |
| t_{SID} (LVTTTL) | LVTTTL input delay: Low Voltage TTL for 3.3 V applications | - | 0.34 ns |
| t_{SID} (LVCMOS2) | LVCMOS2 input delay: Low Voltage CMOS for 2.5 V and lower applications | - | 0.42 ns |
| t_{SID} (GTL+) | GTL+ input delay: Gunning Transceiver Logic | - | 0.68 ns |
| t_{SID} (SSTL3) | SSTL3 input delay: Stub Series Terminated Logic for 3.3 V | - | 0.55 ns |
| t_{SID} (SSTL2) | SSTL2 input delay: Stub Series Terminated Logic for 2.5 V | - | 0.61 ns |

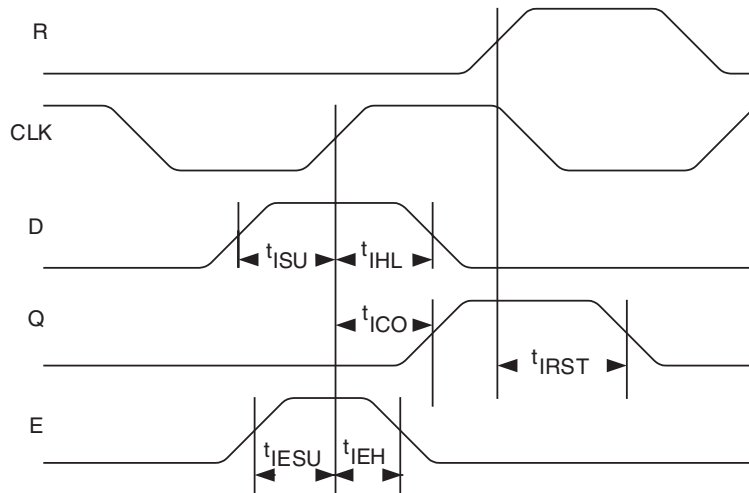


Figure 13: EclipsePlus Input Register Cell Timing

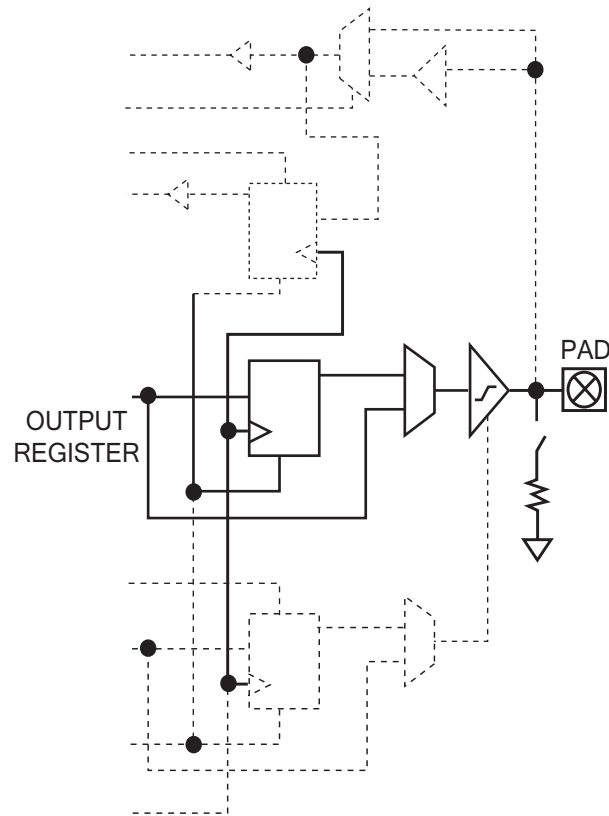


Figure 14: EclipsePlus Output Register Cell

Table 7: EclipsePlus Output Register Cell

| Symbol | Parameter | Value | |
|----------------------------------|---|-------|--|
| | | Min | Max |
| Output Register Cell Only | | | |
| t_{OUTLH} | Output Delay low to high (90% of H) | - | 0.40 ns |
| t_{OUTHl} | Output Delay high to low (10% of L) | - | 0.55 ns |
| t_{PZH} | Output Delay tri-state to high (90% of H) | - | 2.94 ns |
| t_{PZL} | Output Delay tri-state to low (10% of L) | - | 2.34 ns |
| t_{PHZ} | Output Delay high to tri-State | - | 3.07 ns |
| t_{PLZ} | Output Delay low to tri-State | - | 2.53 ns |
| t_{COP} | Clock-to-out delay (does not include clock tree delays) | - | 3.15 ns (fast slew) 10.2 ns (slow slew) |

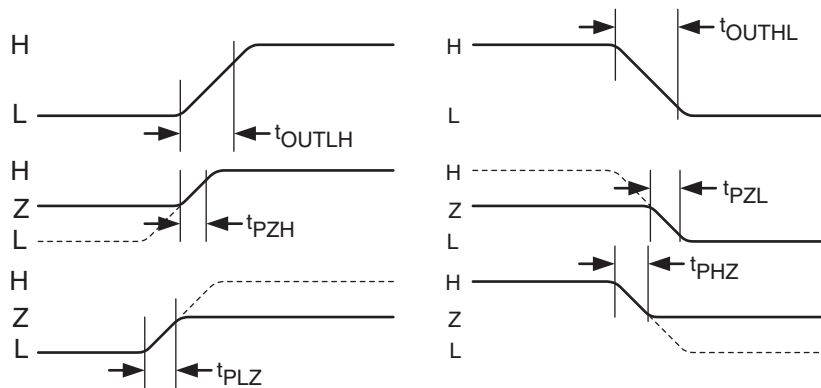


Figure 15: EclipsePlus Output Register Cell Timing

Table 8: Output Slew Rates @ $V_{CCIO} = 3.3\text{ V}$

| | Fast Slew | Slow Slew |
|--------------|-----------|-----------|
| Rising Edge | 2.8 V/ns | 1.0 V/ns |
| Falling Edge | 2.86 V/ns | 1.0 V/ns |

Table 9: Output Slew Rates @ $V_{CCIO} = 2.5\text{ V}$

| | Fast Slew | Slow Slew |
|--------------|-----------|-----------|
| Rising Edge | 1.7 V/ns | 0.6 V/ns |
| Falling Edge | 1.9 V/ns | 0.6 V/ns |

NOTE: For tips to minimize ground bounce, refer to Application Note 66 at <http://www.quicklogic.com/images/appnote66.pdf>.

DC Characteristics

The DC Specifications are provided in **Table 10** through **Table 13**.

Table 10: Absolute Maximum Ratings

| Parameter | Value | Parameter | Value |
|----------------------------|------------------------------------|--|--------------------|
| V _{CC} Voltage | -0.5 V to 3.6 V | DC Input Current | ±20 mA |
| V _{CCIO} Voltage | -0.5 V to 4.6 V | ESD Pad Protection | ±2000 V |
| INREF Voltage | 2.7 V | Leaded Package Storage Temperature | -65° C to + 150° C |
| Input Voltage ^a | -0.5 V to V _{CCIO} +0.5 V | Laminate Package (BGA) Storage Temperature | -55° C to + 125° C |
| Latch-up Immunity | ±100 mA | | |

a. All dedicated inputs including the CLK, DEDCLK, PLLIN, PLLRST, and IOCTRL pins, are clamped to the V_{CC} rail, not the V_{CCIO}. Therefore, these pins can only be driven up to V_{CC} + 0.3 V. These input pins are LVCMOS2 compliant only (2.5 V).

Table 11: Operating Range

| Symbol | Parameter | Military | | Industrial | | Commercial | | Unit | |
|-------------------|-----------------------------|----------------|------|------------|------|------------|------|------|-----|
| | | Min | Max | Min | Max | Min | Max | | |
| V _{CC} | Supply Voltage | 2.3 | 2.7 | 2.3 | 2.7 | 2.3 | 2.7 | V | |
| V _{CCIO} | I/O Input Tolerance Voltage | 2.3 | 3.6 | 2.3 | 3.6 | 2.3 | 3.6 | V | |
| TA | Ambient Temperature | -55 | | -40 | 85 | 0 | 70 | °C | |
| TC | Case Temperature | - | 125 | - | - | - | - | °C | |
| K | Delay Factor | -4 Speed Grade | 0.42 | 2.3 | 0.43 | 2.16 | 0.47 | 2.11 | n/a |
| | | -5 Speed Grade | 0.42 | 1.92 | 0.43 | 1.80 | 0.46 | 1.76 | n/a |
| | | -6 Speed Grade | 0.42 | 1.35 | 0.43 | 1.26 | 0.46 | 1.23 | n/a |
| | | -7 Speed Grade | 0.42 | 1.27 | 0.43 | 1.19 | 0.46 | 1.16 | n/a |

Table 12: DC Characteristics

| Symbol | Parameter | Conditions | Min | Max | Units |
|------------------------|--|--------------------------------------|------------|-------------|----------------------------|
| I_I | I or I/O Input Leakage Current | $V_I = V_{CCIO}$ or GND | -10 | 10 | μA |
| I_{OZ} | 3-State Output Leakage Current | $V_I = V_{CCIO}$ or GND | -10 | 10 | μA |
| C_I | Input Capacitance ^a | - | - | 8 | pF |
| I_{OS} | Output Short Circuit Current ^b | $V_o = \text{GND}$ $V_o = V_{CC}$ | -15 40 | -180 210 | mA mA |
| I_{CC} | D.C. Supply Current ^c | $V_I, V_o = V_{CCIO}$ or GND | 0.50 (typ) | 2 | mA |
| I_{CCIO} | D.C. Supply Current on V_{CCIO} | - | 0 | 2 | mA |
| $I_{CCIO}(\text{DIF})$ | D.C. Supply Current on V_{CCIO} for Differential I/O | - | - | - | mA |
| I_{REF} | D.C. Supply Current on INREF | - | -10 | 10 | μA |
| I_{PD} | Pad Pull-down (programmable) | $V_{CCIO} = 3.6 \text{ V}$ | - | 150 | μA |

- a. Capacitance is sample tested only. Clock pins are 12 pF maximum.
 b. Only one output at a time. Duration should not exceed 30 seconds.
 c. For -4/-5/-6/-7 commercial grade devices only. See **Table 13** for more details on I_{CC} characteristics.

Table 13: I_{CC} Characteristics

| Characteristic | Condition | Temperature | | |
|----------------|--------------------------|---------------|------------|-------------|
| | | Commercial | Industrial | Military |
| I_{CC} | $V_{CCPLL} = \text{GND}$ | 2 mA (max) | 3 mA (max) | 5 mA (max) |
| | $V_{CCPLL} = V_{CC}$ | 3.25 mA (max) | 5 mA (max) | 10 mA (max) |

NOTE: If PLLs are not used, the V_{CCPLL} and PLLRST pins may be grounded to the lower I_{CC} for the device.

Embedded Computational Unit (ECU)

Traditional Programmable Logic architectures do not implement arithmetic functions efficiently or effectively—these functions require high logic cell usage while garnering only moderate performance results.

The QL7120 architecture allows for functionality above and beyond that achievable using programmable logic devices. By embedding a dynamically reconfigurable computational unit, the QL7120 device can address various arithmetic functions efficiently. This approach offers greater performance than traditional programmable logic implementations. The embedded block is implemented at the transistor level as shown in **Figure 16**.

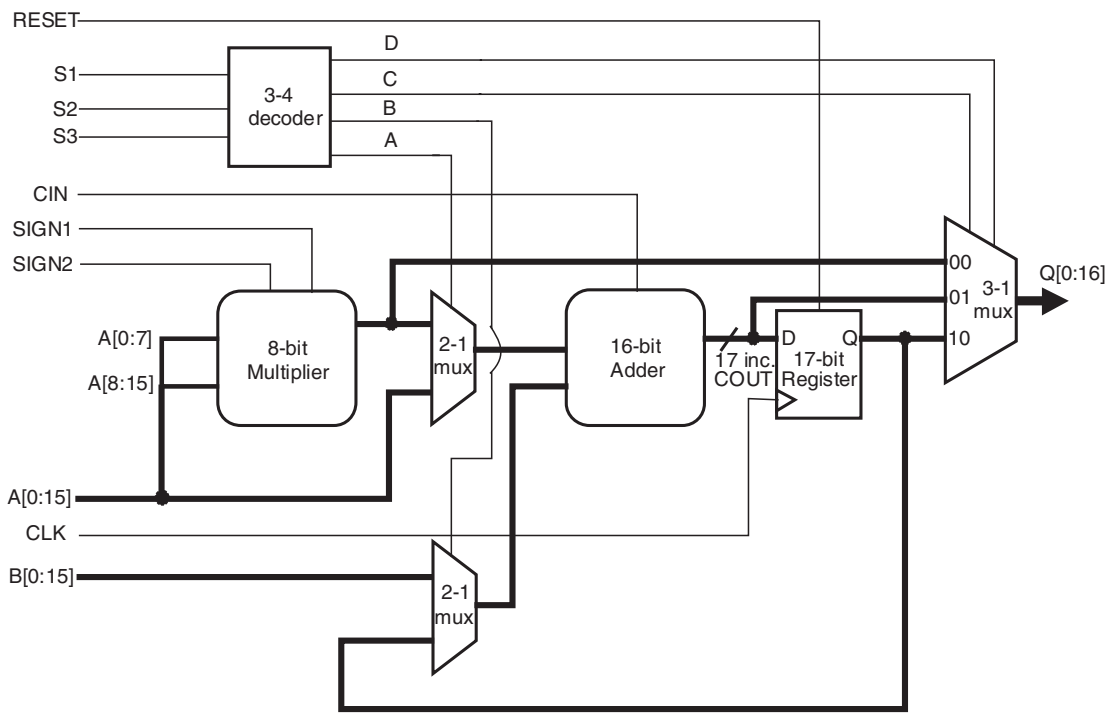


Figure 16: ECU Block Diagram

The 12 QL7120 ECU blocks are placed next to the SRAM circuitry for efficient memory/instruction fetch and addressing for DSP algorithmic implementations.

Twelve 8-bit Multiply-Accumulate (MAC) functions can be implemented per cycle for a total of 1.2 billion MACs when clocked at 100 MHz. Additional MAC functions can be implemented in the programmable logic.

The modes for the ECU block are dynamically re-programmable through the programmable logic as shown in **Table 14**.

Table 14: ECU Mode Select Criteria

| Instruction | | | Operation | ECU Performance ^a , -7 WCC ^b | | |
|-------------|----|----|------------------------------------|--|-----------------|-----------------|
| S1 | S2 | S3 | | t _{PD} | t _{SU} | t _{CO} |
| 0 | 0 | 0 | Multiply | 6.57 ns max | | |
| 0 | 0 | 1 | Multiply-Add | 8.84 ns max | | |
| 0 | 1 | 0 | Accumulate ^c | | 3.91 ns min | 1.16 ns max |
| 0 | 1 | 1 | Add | 3.14 ns max | | |
| 1 | 0 | 0 | Multiply (registered) ^d | | 9.61 ns min | 1.16 ns max |
| 1 | 0 | 1 | Multiply- Add (registered) | | 9.61 ns min | 1.16 ns max |
| 1 | 1 | 0 | Multiply - Accumulate | | 9.61 ns min | 1.16 ns max |
| 1 | 1 | 1 | Add (registered) | | 3.91 ns min | 1.16 ns max |

- a. t_{PD}, t_{SU} and t_{CO} do not include routing paths in/out of the ECU block.
- b. Timing numbers represent -7 Worst Case Commercial conditions.
- c. Internal feedback path in ECU restricts max clk frequency to 238 MHz.
- d. B [15:0] set to zero.

Phase Locked Loops (PLLs)

Instead of requiring extra components, designers simply need to instantiate one of the pre-configured models described in this section and listed in [Table 15](#). The QuickLogic built-in PLLs support a wider range of frequencies than many other PLLs. Also, QuickLogic PLLs can be cascaded to support different ranges of frequency multiplications or divisions, driving the device at a faster or slower rate than the incoming clock frequency. Most importantly, they achieve a very short clock-to-out time—generally less than 3 ns. This low clock-to-out time is achieved by the PLL subtracting the clock tree delay through the feedback path, effectively making the clock tree delay zero.

Figure 17 illustrates a typical QuickLogic ESP PLL.

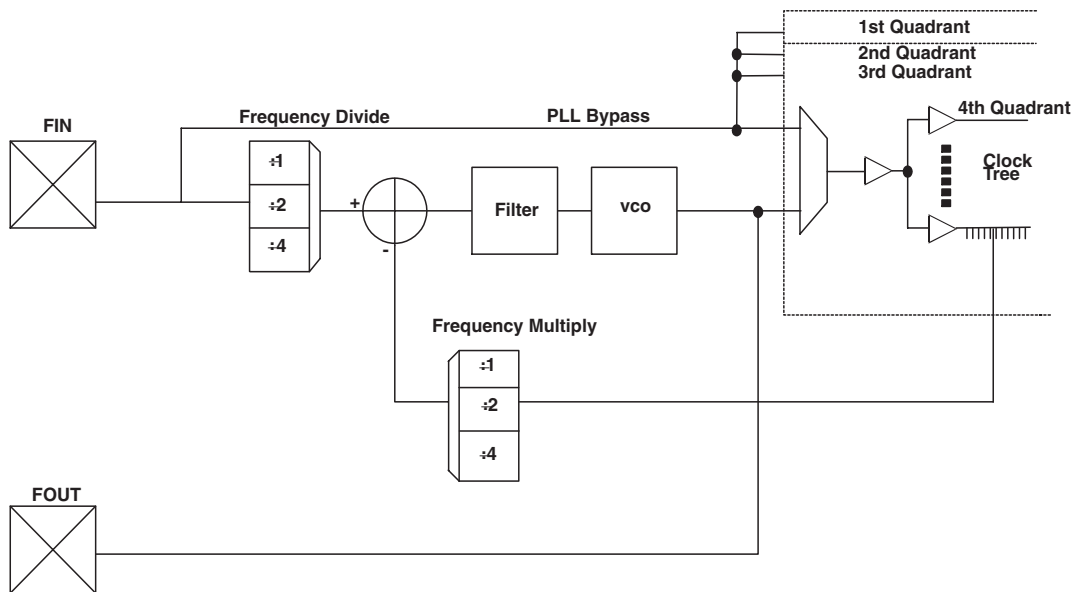


Figure 17: PLL Block

F_{in} represents a very stable high-frequency input clock and produces an accurate signal reference. This signal can either bypass the PLL entirely, thus entering the clock tree directly, or it can pass through the PLL itself.

Within the PLL, a voltage-controlled oscillator (VCO) is added to the circuit. The external F_{in} signal and the local VCO form a control loop. The VCO is multiplied or divided down to the reference frequency, so that a phase detector (the crossed circle in [Figure 17](#)) can compare the two signals. If the phases of the external and local signals are not within the tolerance required, the phase detector sends a signal through the charge pump and loop filter ([Figure 17](#)). The charge pump generates an error voltage to bring the VCO back into alignment and the loop filter removes any high frequency noise before the error voltage enters the VCO. This new VCO signal enters the clock tree to drive the chip's circuitry.

F_{out} represents the clock signal that emerges from the output pad (the output signal PLLPAD_OUT is explained in **Table 16**). This clock signal is meaningful only when the PLL is configured for external use; otherwise, it remains in high Z state, as shown in the post-simulation waveform.

Most QuickLogic products contain four PLLs, one to be used in each quadrant. The PLL presented in **Figure 17** controls the clock tree in the fourth Quadrant of its ESP. As previously noted, QuickLogic PLLs compensate for the additional delay created by the clock tree itself by subtracting the clock tree delay through the feedback path.

For more specific information on the Phase Locked Loops, please refer to Application Note 58 at <http://www.quicklogic.com/images/appnote58.pdf>

PLL Modes of Operation

QuickLogic PLLs have eight modes of operation, based on the input frequency and desired output frequency—**Table 15** indicates the features of each mode.

Table 15: PLL Mode Frequencies

| PLL Model | Output Frequency | Input Frequency Range ^a | Output Frequency Range |
|---------------------|-------------------------|------------------------------------|------------------------|
| PLL_HF ^b | Same as input frequency | 66 MHz–150 MHz | 66 MHz–150 MHz |
| PLL_LF | Same as input frequency | 25 MHz–133 MHz | 25 MHz–133 MHz |
| PLL_MULT2HF | 2 × input frequency | 50 MHz–125 MHz | 100 MHz–250 MHz |
| PLL_MULT2LF | 2 × input frequency | 16 MHz–50 MHz | 32 MHz–100 MHz |
| PLL_DIV2HF | 1/2 × input frequency | 100 MHz–250 MHz | 50 MHz–125 MHz |
| PLL_DIV2LF | 1/2 × input frequency | 50 MHz–100 MHz | 25 MHz–50 MHz |
| PLL_MULT4 | 4 × input frequency | 16 MHz–40 MHz | 64 MHz–160 MHz |
| PLL_DIV4 | 1/4 × input frequency | 100 MHz–300 MHz | 25 MHz–75 MHz |

- a. The input frequency can range from 12.5 MHz to 500 MHz, while output frequency ranges from 25 MHz to 250 MHz. When you add PLLs to your top-level design, be sure that the PLL mode matches your desired input and output frequencies.
- b. HF stands for high frequency and LF stands for low frequency.

PLL Signals

Table 16 summarizes the key signals in QuickLogic’s PLLs.

Table 16: PLL Signals

| Signal Name | Description |
|------------------------|---|
| PLLCLK_IN ^a | Input clock signal |
| PLL_RST | Active High Reset If PLL_RST is asserted, then CLKNET_OUT and PLLPAD_OUT are reset to 0. This signal must be asserted and then released in order for the LOCK_DETECT to work. |
| ONn_OFFCHIP | PLL output This signal selects whether the PLL will drive the internal clock network or be used off-chip. This is a static signal, not a dynamic signal. Tied to GND = outgoing signal drives internal gates. Tied to VCC = outgoing signal used off-chip. |
| CLKNET_OUT | Out to internal gates This signal bypasses the PLL logic before driving the internal gates. Note that this signal cannot be used in the same quadrant where the PLL signal is used (PLLCLK_OUT). |
| PLLCLK_OUT | Out from PLL to internal gates This signal can drive the internal gates after going through the PLL. For this to work, ONn_OFFCHIP must be tied to GND. |
| PLLPAD_OUT | Out to off-chip This outgoing signal is used off-chip. For this to work, ONn_OFFCHIP signal must be tied to VCC. |
| LOCK_DETECT | Active High Lock detection signal NOTE: For simulation purposes, this signal gets asserted after 10 clock cycles. However, it can take a maximum of 200 clock cycles to sync with the input clock upon release of the RESET signal. |

- a. Because PLLCLK_IN and PLL_RST signals have INPAD, and PLLPAD_OUT has OUTPAD, you do not have to add additional pads to your design

I/O Characteristics

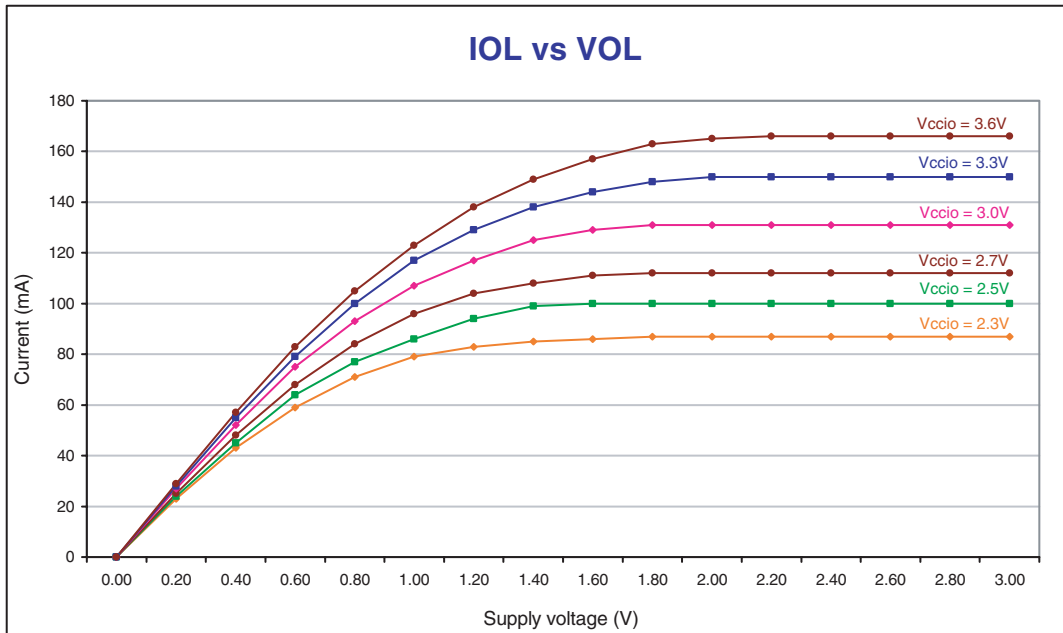


Figure 18: IOL vs. VOL

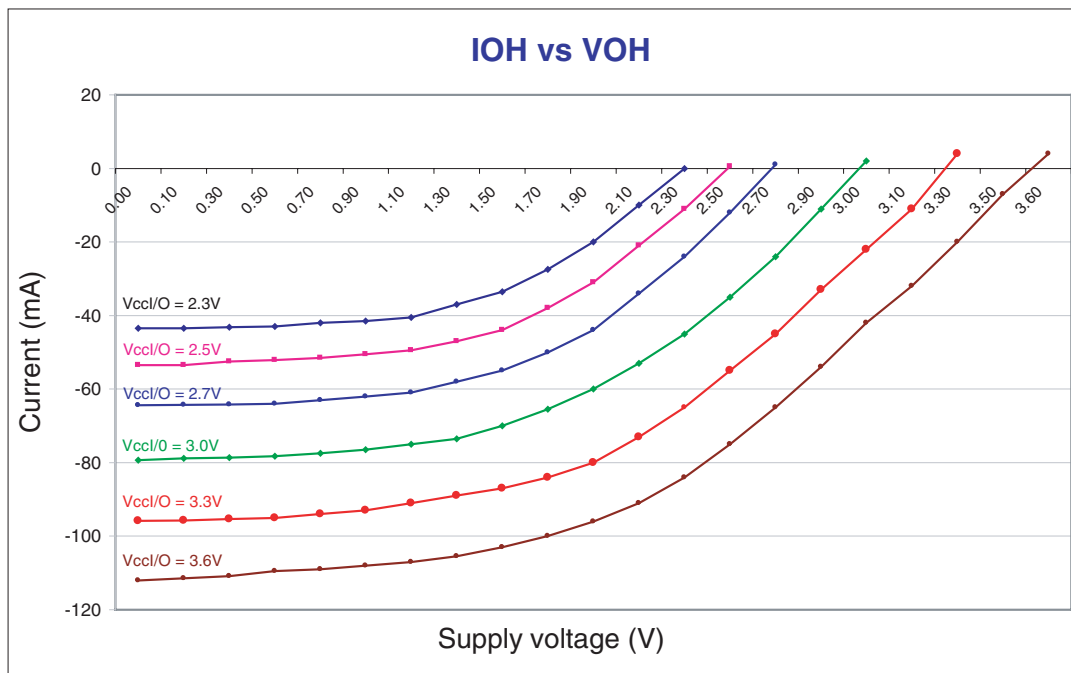


Figure 19: IOH vs. VOH

Table 17: DC Input and Output Levels^a

| | INREF | | V _{IL} | | V _{IH} | | V _{OL} | V _{OH} | I _{OL} | I _{OH} |
|----------|------------------|------------------|------------------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|-----------------|-----------------|
| | V _{MIN} | V _{MAX} | V _{MIN} | V _{MAX} | V _{MIN} | V _{MAX} | V _{MAX} | V _{MIN} | mA | mA |
| LVTTTL | n/a | n/a | -0.3 | 0.8 | 2.0 | V _{CCIO} + 0.3 | 0.4 | 2.4 | 2.0 | -2.0 |
| LVC MOS2 | n/a | n/a | -0.3 | 0.7 | 1.7 | V _{CCIO} + 0.3 | 0.7 | 1.7 | 2.0 | -2.0 |
| GTL+ | 0.88 | 1.12 | -0.3 | INREF - 0.2 | INREF + 0.2 | V _{CCIO} + 0.3 | 0.6 | n/a | 40 | n/a |
| PCI | n/a | n/a | -0.3 | 0.3 x V _{CCIO} | 0.5 x V _{CCIO} | V _{CCIO} + 0.5 | 0.1 x V _{CCIO} | 0.9 x V _{CCIO} | 1.5 | -0.5 |
| SSTL2 | 1.15 | 1.35 | -0.3 | INREF - 0.18 | INREF + 0.18 | V _{CCIO} + 0.3 | 0.74 | 1.76 | 7.6 | -7.6 |
| SSTL3 | 1.3 | 1.7 | -0.3 | INREF - 0.2 | INREF + 0.2 | V _{CCIO} + 0.3 | 1.10 | 1.90 | 8 | -8 |

a. The data provided in **Table 17** are JEDEC and PCI Specifications. QuickLogic devices either meet or exceed these requirements. See preceding **Table 1** through **Table 13** and **Figure 1** through **Figure 17** for data specific to QuickLogic I/Os.

NOTE: All CLK and IOCTRL pins are clamped to the V_{CC} rail, not the V_{CCIO}. Therefore, these pins can only be driven up to V_{CC} + 0.3 V.

NOTE: All dedicated inputs including the CLK, DEDCLK, PLLIN, PLLRST, and IOCTRL pins, are clamped to the V_{CC} rail, not the V_{CCIO}. Therefore, these pins can only be driven up to V_{CC} + 0.3 V. These input pins are LVC MOS2 compliant only (2.5 V).

Table 18: Max I/O per Device /Package Combination

| Device | 208 PQFP | 280 BGA | 484 BGA |
|--------|----------|---------|---------|
| QL7120 | 99 | 163 | 310 |

Package Thermal Characteristics

Thermal Resistance Equations:

$$\theta_{JC} = (T_J - T_C) / P$$

$$\theta_{JA} = (T_J - T_A) / P$$

$$P_{MAX} = (T_{JMAX} - T_{AMAX}) / \theta_{JA}$$

Parameter Description:

θ_{JC} : Junction-to-case thermal resistance

θ_{JA} : Junction-to-ambient thermal resistance

T_J : Junction temperature

T_A : Ambient temperature

P: Power dissipated by the device while operating

P_{MAX} : The maximum power dissipation for the device

T_{JMAX} : Maximum junction temperature

T_{AMAX} : Maximum ambient temperature

NOTE: Maximum junction temperature (T_{JMAX}) is 150° C. To calculate the maximum power dissipation for a device package look up θ_{JA} from **Table 19**, pick an appropriate T_{AMAX} and use:

$$P_{MAX} = (150^\circ \text{ C} - T_{AMAX}) / \theta_{JA}$$

Table 19: Package Thermal Characteristics

| Package Description | | θ_{JA} (° C/W) @ various flow rates (m/sec) | | | | θ_{JC} (° C/W) |
|---------------------|--------------|--|------|------|------|-----------------------|
| Pin Count | Package Type | 0 | 0.5 | 1 | 2 | |
| 484 | PBGA | 28.0 | 26.0 | 25.0 | 23.0 | 9.0 |
| 280 | LF-PBGA | 18.5 | 17.0 | 15.5 | 14.0 | 7.0 |
| 208 | PQFP | 26.0 | 24.5 | 23.0 | 22.0 | 11.0 |

Kv and Kt Graphs

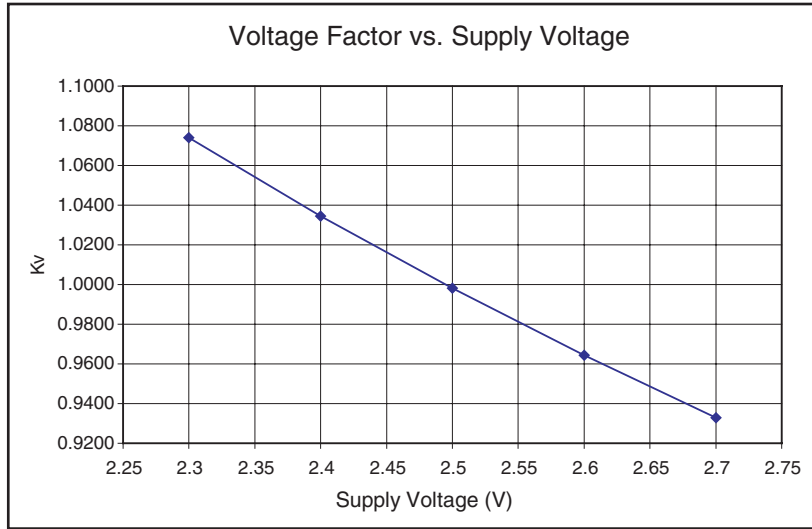


Figure 20: Voltage Factor vs. Supply Voltage

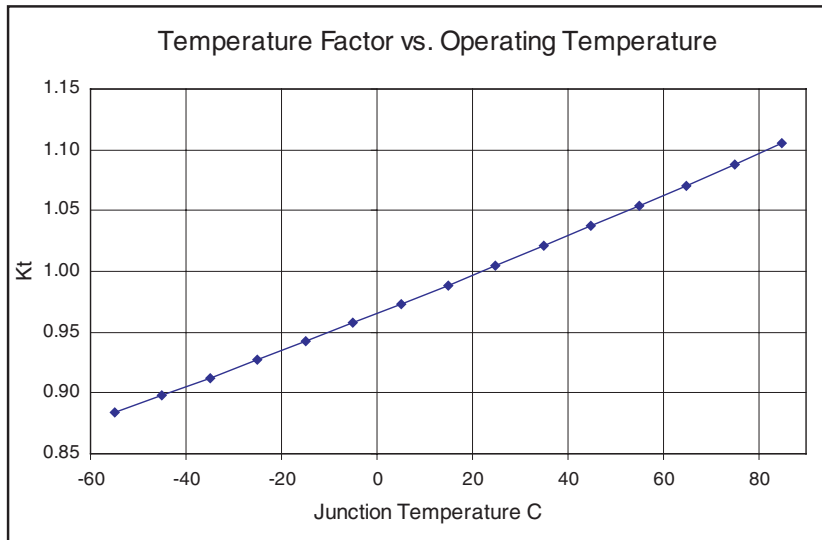


Figure 21: Temperature Factor vs. Operating Temperature

Power vs. Operating Frequency

The basic power equation which best models power consumption is given below:

$$P_{TOTAL} = 0.350 + f[0.0031 \eta_{LC} + 0.0948 \eta_{CKBF} + 0.01 \eta_{CLBF} + 0.0263 \eta_{CKLD} + 0.543 \eta_{RAM} + 0.20 \eta_{PLL} + 0.0035 \eta_{INP} + 0.0257 \eta_{OUTP}] \text{ (mW)}$$

Where

- η_{LC} is the total number of logic cells in the design
- η_{CKBF} = # of clock buffers
- η_{CLBF} = # of column clock buffers
- η_{CKLD} = # of loads connected to the column clock buffers
- η_{RAM} = # of RAM blocks
- η_{PLL} = # of PLLs
- η_{INP} is the number of input pins
- η_{OUTP} is the number of output pins

Figure 22 exhibits the power consumption in an EclipsePlus QL7120 device. The chip was filled with (300) 8-bit counters—approximately 76% logic cell utilization.

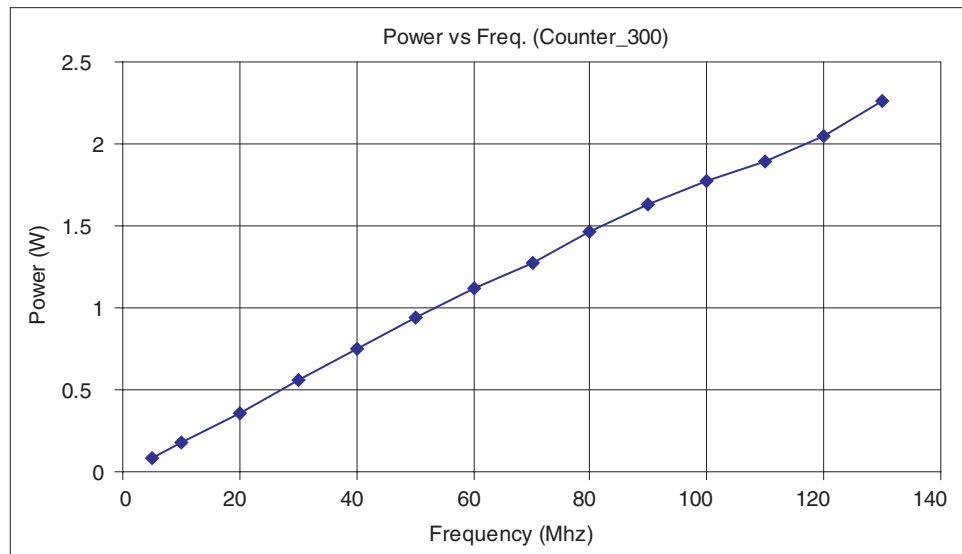


Figure 22: Power Consumption

Figure 23 illustrates the theoretical worst-case scenarios for 50%, 70%, and 90% utilizations of the 6600-516 package. The resources of the device are divided exactly in half; meaning, for 50% utilization, exactly 50% of the I/Os, Logic Cells, RAM blocks, clock network, etc. are utilized. These situations may never occur in a real design, but they do provide a very rough quantitative measure of power consumption when talking in terms of 50% or 70% utilization of an EclipsePlus device.

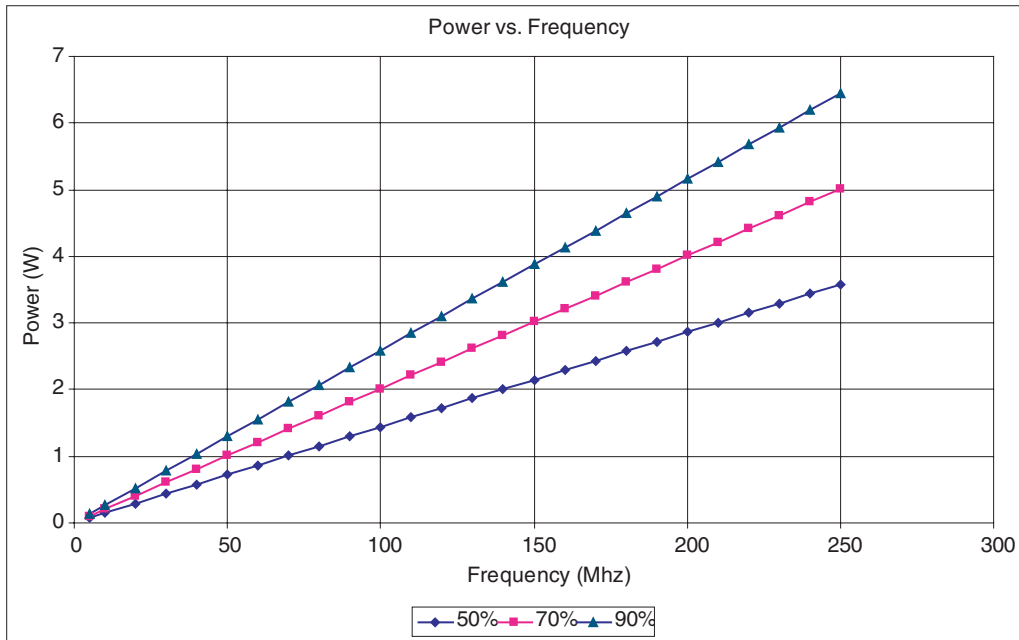


Figure 23: Power vs. Frequency (Absolute 50%, 70%, and 90% of the Available Resources on Chip)

To learn more about power consumption, please refer to application note #60 which is located at <http://www.quicklogic.com/images/appnote60.pdf>.

Power-up Sequencing

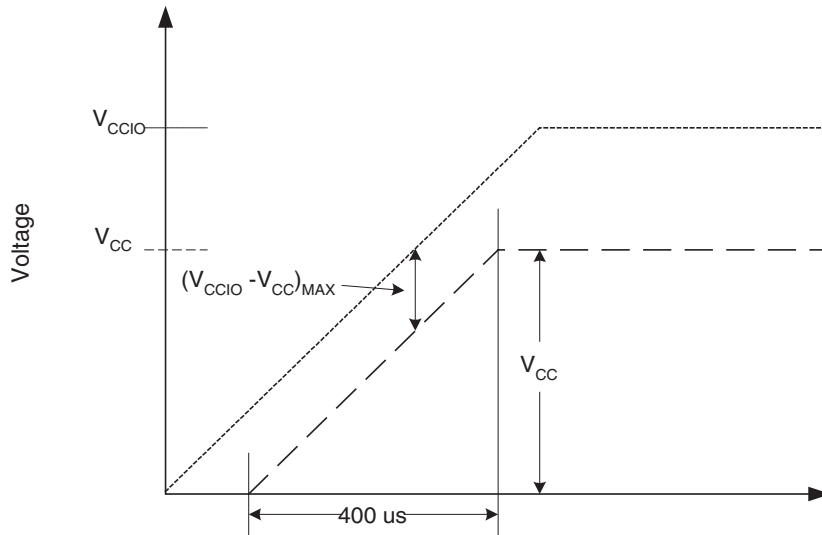


Figure 24: Power-up Requirements

When powering up a device, the V_{CC}/V_{CCIO} rails must take 400 μ s or longer to reach the maximum value (refer to **Figure 24**).

NOTE: Ramping V_{CC}/V_{CCIO} to the maximum voltage faster than 400 μ s can cause the device to behave improperly.

For users with a limited power budget, keep $(V_{CCIO} - V_{CC})_{MAX} \leq 500$ mV when ramping up the power supply.

Joint Test Access Group (JTAG)

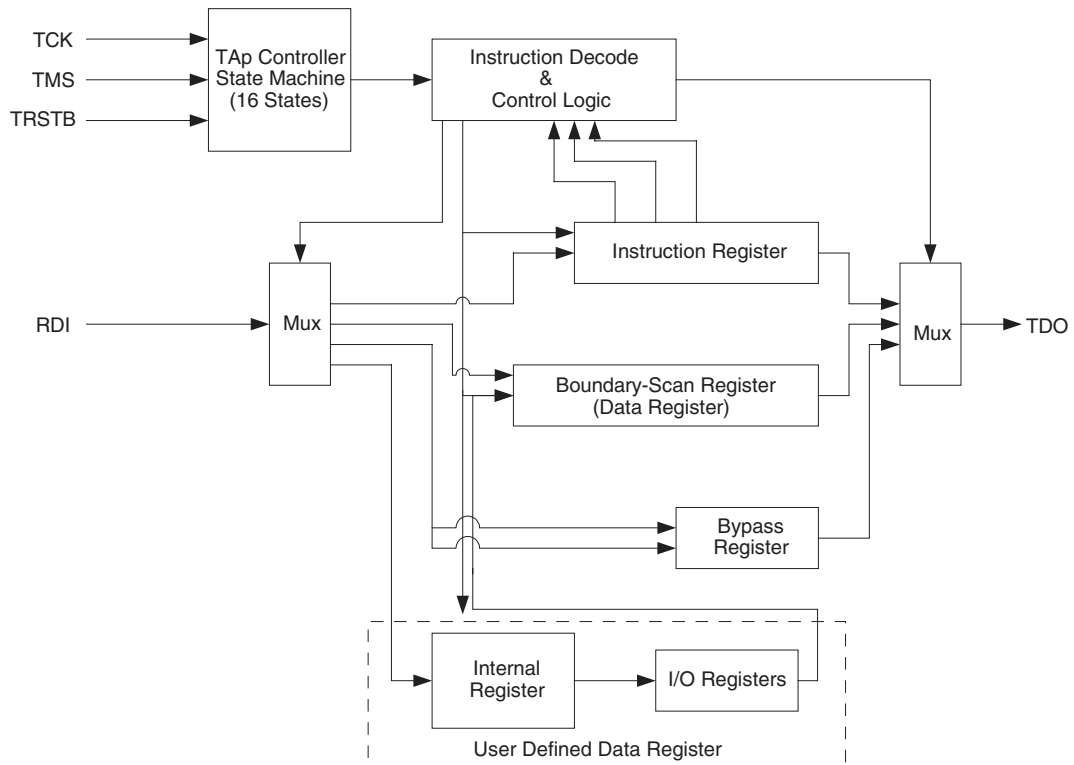


Figure 25: JTAG Block Diagram

Microprocessors and Application Specific Integrated Circuits (ASICs) pose many design challenges, one problem being the accessibility of test points. The Joint Test Access Group (JTAG) formed in response to this challenge, resulting in IEEE standard 1149.1, the Standard Test Access Port and Boundary Scan Architecture.

The JTAG boundary scan test methodology allows complete observation and control of the boundary pins of a JTAG-compatible device through JTAG software. A Test Access Port (TAP) controller works in concert with the Instruction Register (IR), which allow users to run three required tests along with several user-defined tests.

JTAG tests allow users to reduce system debug time, reuse test platforms and tools, and reuse subsystem tests for fuller verification of higher level system elements.

The 1149.1 standard requires the following three tests:

- **Extest Instruction.** The Extest instruction performs a PCB interconnect test. This test places a device into an external boundary test mode, selecting the boundary scan register to be connected between the TAP's Test Data In (TDI) and Test Data Out (TDO) pins. Boundary scan cells are preloaded with test patterns (via the Sample/Preload Instruction), and input boundary cells capture the input data for analysis.
- **Sample/Preload Instruction.** This instruction allows a device to remain in its functional mode, while selecting the boundary scan register to be connected between the TDI and TDO pins. For this test, the boundary scan register can be accessed via a data scan operation, allowing users to sample the functional data entering and leaving the device.
- **Bypass Instruction.** The Bypass instruction allows data to skip a device's boundary scan entirely, so the data passes through the bypass register. The Bypass instruction allows users to test a device without passing through other devices. The bypass register is connected between the TDI and TDO pins, allowing serial data to be transferred through a device without affecting the operation of the device.

Pin Descriptions

Table 20: JTAG Pin Descriptions

| Pin | Function | Description |
|-----------|--|--|
| TDI/RSI | Test Data In for JTAG/RAM init. Serial Data In | Hold HIGH during normal operation. Connects to serial PROM data in for RAM initialization. Connect to V_{CC} if unused |
| TRSTB/RRO | Active low Reset for JTAG/RAM init. reset out | Hold LOW during normal operation. Connects to serial PROM reset for RAM initialization. Connect to GND if unused |
| TMS | Test Mode Select for JTAG | Hold HIGH during normal operation. Connect to V_{CC} if not used for JTAG |
| TCK | Test Clock for JTAG | Hold HIGH or LOW during normal operation. Connect to V_{CC} or ground if not used for JTAG |
| TDO/RCO | Test data out for JTAG/RAM init. clock out | Connect to serial PROM clock for RAM initialization. Must be left unconnected if not used for JTAG or RAM initialization |

NOTE: All JTAG inputs are clamped to the V_{CC} rail, not the V_{CCIO} . Therefore, these pins can only be driven up to $V_{CC} + 0.3$ V. These input pins are LVCMOS2 compliant only (2.5 V). All JTAG outputs are driven by the V_{CC} rail, not V_{CCIO} . Therefore, these output pins can only drive up to $V_{CC} + 0.3$ V. These output pins are LVCMOS2 compliant only (2.5 V).

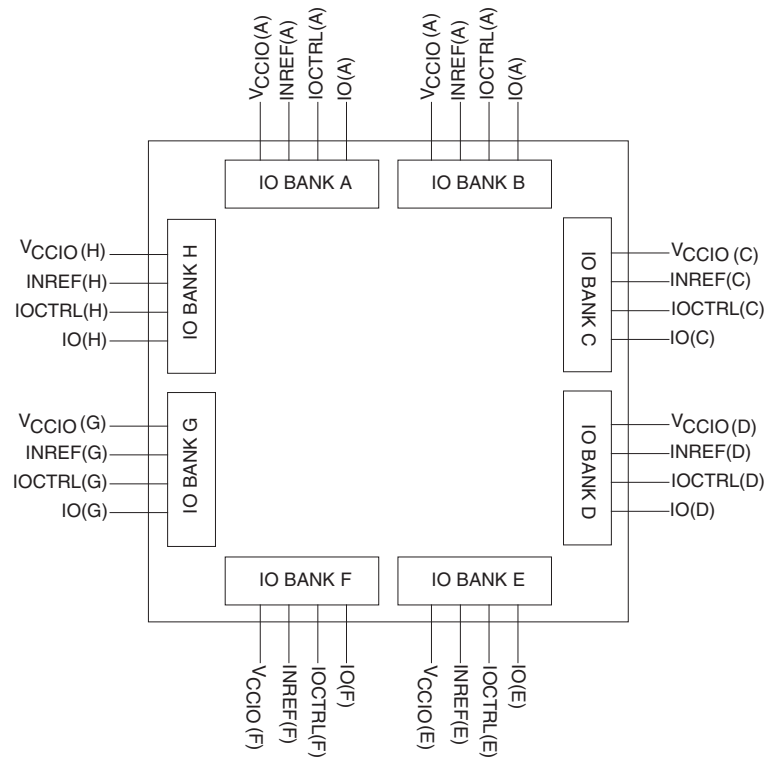


Figure 26: I/O Banks with Relevant Pins

Table 21: Dedicated Pin Descriptions

| Pin | Direction | Function | Description |
|---------------------------------|-----------|------------------------------------|--|
| CLK ^a | I | Global clock network driver | Low skew global clock. This pin provides access to a dedicated, distributed network capable of driving the CLOCK, SET, RESET, F1, and A2 inputs to the Logic Cell, READ, and WRITE CLOCKS, Read and Write Enables of the Embedded RAM Blocks, CLOCK of the ECUs, and Output Enables of the I/Os. |
| I/O(A) | I/O | Input/Output pin | The I/O pin is a bi-directional pin, configurable to either an input-only, output-only, or bi-directional pin. The A inside the parenthesis means that the I/O is located in Bank A. If an I/O is not used, SpDE (QuickWorks Tool) provides the option of tying that pin to GND, V _{CC} , or TriState during programming. |
| V _{CC} | I | Power supply pin | Connect to 2.5 V supply |
| V _{CCIO} (A) | I | Input voltage tolerance pin | This pin provides the flexibility to interface the device with either a 3.3 V device or a 2.5 V device. The A inside the parenthesis means that V _{CCIO} is located in BANK A. Every I/O pin in Bank A will be tolerant of V _{CCIO} input signals and will output V _{CCIO} level signals. This pin must be connected to either 3.3 V or V _{CC} . |
| V _{CCPLL} ^b | I | Phase locked loop power supply pin | Connect to 2.5 V supply. VCCPLL should be connected to 2.5 V supply if the PLLs are used. If the PLLs are not used, V _{CCPLL} can be connected to 2.5 V supply or GND. See Table 13 for for I ^{CC} differences when V _{CCPLL} is connected to 2.5 V or GND. |
| GND | I | Ground pin | Connect to ground |
| PLLIN ^a | I | PLL clock input | Clock input for PLL |
| DEDCLK ^a | I | Dedicated clock pin | Low skew global clock. This pin provides access to a dedicated, distributed clock network capable of driving the CLOCK inputs of all sequential elements of the device (e.g. RAM, Flip Flops). |
| GNDPLL | I | Ground pin for PLL | Connect to GND |
| INREF(A) | I | Differential reference voltage | The INREF is the reference voltage pin for GTL+, SSTL2, and STTL3 standards. Follow the recommendations provided in Table 17 for the appropriate standard. The A inside the parenthesis means that INREF is located in BANK A. This pin should be tied to GND if not needed. |
| PLLOUT | O | PLL output pin | Dedicated PLL output pin. Otherwise may be left unconnected |
| PLL _{RST} ^a | I | Reset input pin for PLL | Reset input for PLL. If PLLs are not used, PLL _{RST} should be connected to the same voltage as V _{CCPLL} (e.g., V _{CC} or GND). |
| IOCTRL(A) ^a | I | Highdrive input | This pin provides fast RESET, SET, CLOCK, and ENABLE access to the I/O cell flip-flops, providing fast clock-to-out and fast I/O response times. This pin can also double as a high-drive pin to the internal logic cells. The A inside the parenthesis means that IOCTRL is located in Bank A. This pin should be tied to GND or V _{CC} if it is not used. |

- a. All dedicated inputs including the CLK, DEDCLK, PLLIN, PLL_{RST}, and IOCTRL pins, are clamped to the V_{CC} rail, not the V_{CCIO}. Therefore, these pins can only be driven up to V_{CC} + 0.3 V. These input pins are LVCMOS2 compliant only (2.5 V).
- b. All PLLOUT output pins are driven by the V_{CC} rail, not the V_{CCIO} rail. These output pins are LVCMOS2 compliant only (2.5 V).

Recommended Unused Pin Terminations for the EclipsePlus devices

All unused, general purpose I/O pins can be tied to V_{CC} , GND, or HIZ (high impedance) internally using the Configuration Editor. This option is given in the bottom-right corner of the placement window. To use the Placement Editor, choose **Constraint > Fix Placement** in the Option pull-down menu of SpDE.

The rest of the pins should be terminated at the board level in the manner presented in **Table 22**.

Table 22: Recommended Unused Pin Terminations

| Signal Name | Recommended Termination |
|------------------------|---|
| PLLOUT<x> ^a | Unused PLL output pins must be connected to either V_{CC} or GND so that their associated input buffer never floats. Utilized PLL output pins that route the PLL clock outside of the chip should not be tied to either V_{CC} or GND. |
| IOCTRL<y> ^b | Any unused pins of this type must be connected to either V_{CC} or GND. |
| CLK/PLLIN<x> | Any unused clock pins should be connected to V_{CC} or GND. |
| PLLRST<x> | If a PLL module is not used, then the associated PLLRST<x> must be connected to V_{CC} ; under normal operation, use it as needed. If PLLs are not used, the associated PLLRST pin must be connected to the same voltage as V_{CCPLL} (2.5 V or GND). |
| INREF<y> | If an I/O bank does not require the use of INREF signal the pin should be connected to GND. |

a. x represents a number.

b. y represents an alphabetical character.

208 PQFP Pinout Diagram

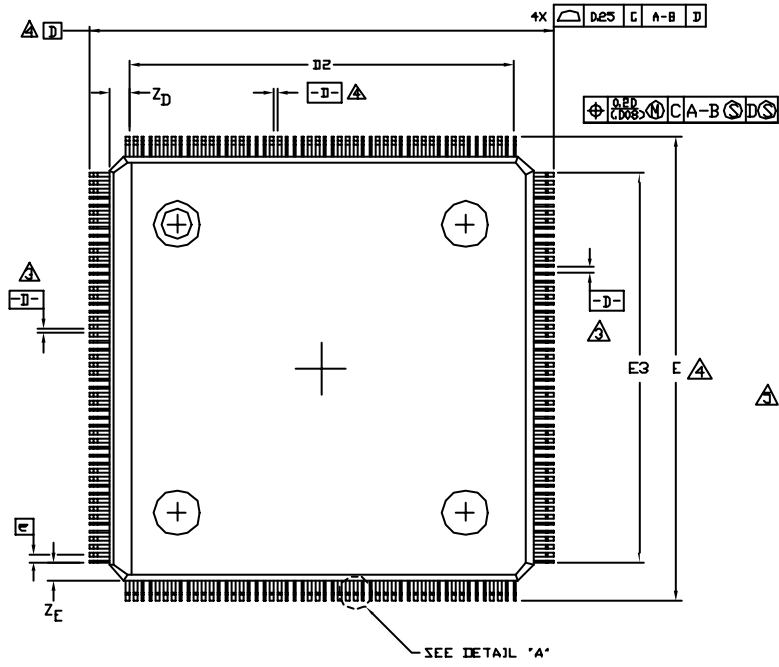


208 PQFP Pinout Table

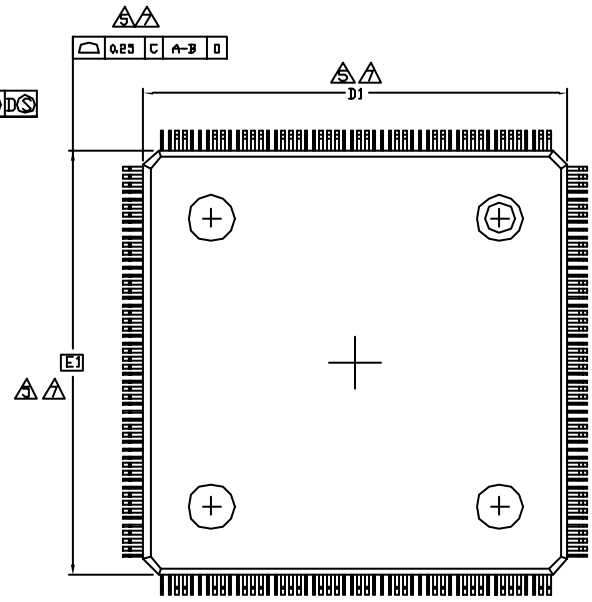
Table 23: 208 PQFP Pinout Table

| PQFP | Function | PQFP | Function | PQFP | Function | PQFP | Function | PQFP | Function |
|------|----------------------------|------|------------------------|------|------------------------|------|------------------------|------|-----------------------|
| 1 | PLLST(3) | 43 | IO(B) | 85 | IO(D) | 127 | CLK(5),PLLIN(3) | 169 | IOCTRL(G) |
| 2 | V _{CCPLL} (3) | 44 | V _{CCIO} (B) | 86 | V _{CC} | 128 | CLK(6) | 170 | INREF(G) |
| 3 | GND | 45 | IO(B) | 87 | IO(D) | 129 | V _{CC} | 171 | IOCTRL(G) |
| 4 | GND | 46 | V _{CC} | 88 | IO(D) | 130 | CLK(7) | 172 | IO(G) |
| 5 | IO(A) | 47 | IO(B) | 89 | V _{CC} | 131 | V _{CC} | 173 | IO(G) |
| 6 | IO(A) | 48 | IO(B) | 90 | IO(D) | 132 | CLK(8) | 174 | IO(G) |
| 7 | IO(A) | 49 | GND | 91 | IO(D) | 133 | TMS | 175 | V _{CC} |
| 8 | V _{CCIO} (A) | 50 | TDO | 92 | IOCTRL(D) | 134 | IO(F) | 176 | IO(G) |
| 9 | IO(A) | 51 | PLLOUT(1) | 93 | INREF(D) | 135 | IO(F) | 177 | V _{CCIO} (G) |
| 10 | IO(A) | 52 | GNDPLL(2) | 94 | IOCTRL(D) | 136 | IO(F) | 178 | GND |
| 11 | IOCTRL(A) | 53 | GND | 95 | IO(D) | 137 | GND | 179 | IO(G) |
| 12 | V _{CC} | 54 | V _{CCPLL} (2) | 96 | IO(D) | 138 | V _{CCIO} (F) | 180 | IO(G) |
| 13 | INREF(A) | 55 | PLLST(2) | 97 | IO(D) | 139 | IO(F) | 181 | IO(G) |
| 14 | IOCTRL(A) | 56 | V _{CC} | 98 | V _{CCIO} (D) | 140 | IO(F) | 182 | V _{CC} |
| 15 | IO(A) | 57 | IO(C) | 99 | IO(D) | 141 | IO(F) | 183 | TCK |
| 16 | IO(A) | 58 | GND | 100 | IO(D) | 142 | IO(F) | 184 | V _{CC} |
| 17 | IO(A) | 59 | IO(C) | 101 | GND | 143 | IO(F) | 185 | IO(H) |
| 18 | IO(A) | 60 | V _{CCIO} (C) | 102 | PLLOUT(0) | 144 | IOCTRL(F) | 186 | IO(H) |
| 19 | V _{CCIO} (A) | 61 | IO(C) | 103 | GND | 145 | INREF(F) | 187 | IO(H) |
| 20 | IO(A) | 62 | IO(C) | 104 | GNDPLL(1) | 146 | V _{CC} | 188 | GND |
| 21 | GND | 63 | IO(C) | 105 | PLLST(1) | 147 | IOCTRL(F) | 189 | V _{CCIO} (H) |
| 22 | IO(A) | 64 | IO(C) | 106 | V _{CCPLL} (1) | 148 | IO(F) | 190 | IO(H) |
| 23 | TDI | 65 | IO(C) | 107 | IO(E) | 149 | IO(F) | 191 | IO(H) |
| 24 | CLK(0) | 66 | IO(C) | 108 | GND | 150 | V _{CCIO} (F) | 192 | IOCTRL(H) |
| 25 | CLK(1) | 67 | IOCTRL(C) | 109 | IO(E) | 151 | IO(F) | 193 | IO(H) |
| 26 | V _{CC} | 68 | INREF(C) | 110 | IO(E) | 152 | IO(F) | 194 | INREF(H) |
| 27 | CLK(2),PLLIN(2) | 69 | IOCTRL(C) | 111 | V _{CCIO} (E) | 153 | GND | 195 | V _{CC} |
| 28 | CLK(3),PLLIN(1) | 70 | IO(C) | 112 | IO(E) | 154 | IO(F) | 196 | IOCTRL(H) |
| 29 | V _{CC} | 71 | IO(C) | 113 | V _{CC} | 155 | PLLOUT(3) | 197 | IO(H) |
| 30 | CLK(4), DEDCLK,PLLIN(0) | 72 | V _{CCIO} (C) | 114 | IO(E) | 156 | GNDPLL(0) | 198 | IO(H) |
| 31 | IO(B) | 73 | IO(C) | 115 | IO(E) | 157 | GND | 199 | IO(H) |
| 32 | IO(B) | 74 | IO(C) | 116 | IO(E) | 158 | V _{CCPLL} (0) | 200 | IO(H) |
| 33 | GND | 75 | GND | 117 | IOCTRL(E) | 159 | PLLST(0) | 201 | IO(H) |
| 34 | V _{CCIO} (B) | 76 | V _{CC} | 118 | INREF(E) | 160 | GND | 202 | IO(H) |
| 35 | IO(B) | 77 | IO(C) | 119 | IOCTRL(E) | 161 | IO(G) | 203 | V _{CCIO} (H) |
| 36 | IO(B) | 78 | TRSTB | 120 | IO(E) | 162 | V _{CCIO} (G) | 204 | GND |
| 37 | IO(B) | 79 | V _{CC} | 121 | IO(E) | 163 | IO(G) | 205 | IO(H) |
| 38 | IO(B) | 80 | IO(D) | 122 | V _{CCIO} (E) | 164 | IO(G) | 206 | PLLOUT(2) |
| 39 | IOCTRL(B) | 81 | IO(D) | 123 | GND | 165 | V _{CC} | 207 | GND |
| 40 | INREF(B) | 82 | IO(D) | 124 | IO(E) | 166 | IO(G) | 208 | GNDPLL(3) |
| 41 | IOCTRL(B) | 83 | GND | 125 | IO(E) | 167 | IO(G) | | |
| 42 | IO(B) | 84 | V _{CCIO} (D) | 126 | IO(E) | 168 | IO(G) | | |

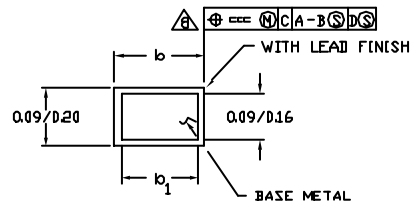
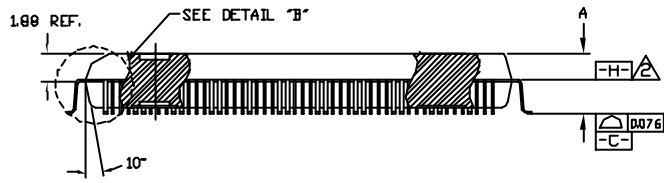
208 PQFP Packaging Drawing



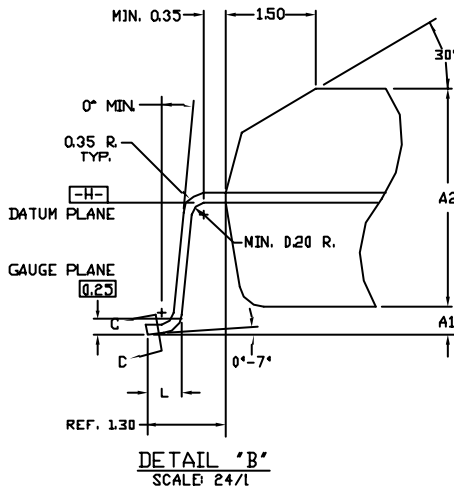
TOP VIEW



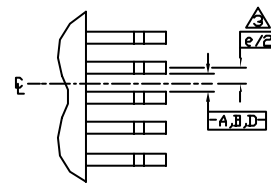
BOTTOM VIEW



SECTION "C-C"
SCALE: NON



DETAIL "B"
SCALE: 24/1



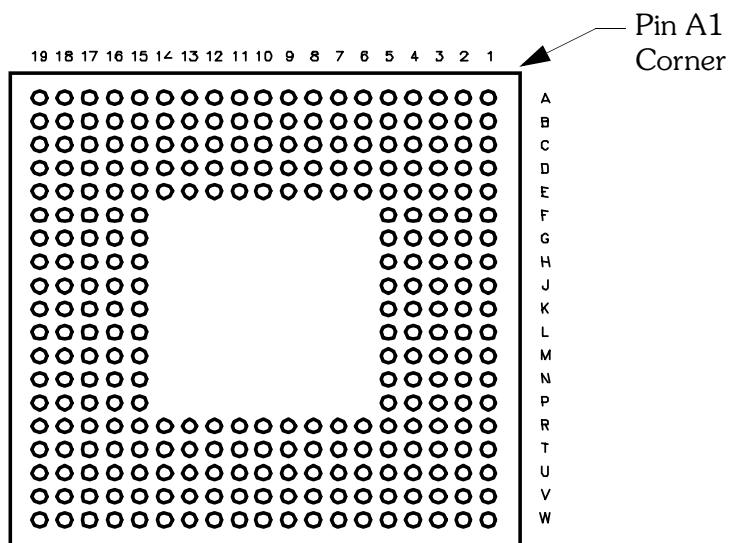
DETAIL "A"
SCALE: 24/1
ROTATED CCW 90°

280 PBGA Pinout Diagram

Top



Bottom



280 PBGA Pinout Table

Table 24: 280 PBGA Pinout Table

| PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function |
|------|-----------------------------|------|----------------------------|------|----------------------------|------|----------------------------|------|-----------------------------|------|----------------------------|
| A1 | PLLOUT<3> | C10 | CLK<5>/PLLIN<3> | E19 | IOCTRL<D> | K16 | I/O<C> | R4 | I/O<H> | U13 | I/O |
| A2 | GNDPLL<0> | C11 | V _{CCIO<E>} | F1 | INREF<G> | K17 | I/O<D> | R5 | GND | U14 | IOCTRL |
| A3 | I/O<F> | C12 | I/O<E> | F2 | IOCTRL<G> | K18 | I/O<C> | R6 | GND | U15 | V _{CCIO} |
| A4 | I/O<F> | C13 | I/O<E> | F3 | I/O<G> | K19 | TRSTB | R7 | V _{CC} | U16 | I/O |
| A5 | I/O<F> | C14 | I/O<E> | F4 | I/O<G> | L1 | I/O<H> | R8 | V _{CC} | U17 | TDO |
| A6 | IOCTRL<F> | C15 | V _{CCIO<E>} | F5 | GND | L2 | I/O<H> | R9 | GND | U18 | PLLRS<2> |
| A7 | I/O<F> | C16 | I/O<E> | F15 | V _{CC} | L3 | V _{CCIO<H>} | R10 | GND | U19 | I/O |
| A8 | I/O<F> | C17 | I/O<E> | F16 | IOCTRL<D> | L4 | I/O<H> | R11 | V _{CC} | V1 | PLLOUT<2> |
| A9 | I/O<F> | C18 | I/O<E> | F17 | I/O<D> | L5 | V _{CC} | R12 | V _{CC} | V2 | GNDPLL<3> |
| A10 | CLK<7> | C19 | I/O<E> | F18 | I/O<D> | L15 | GND | R13 | V _{CC} | V3 | GND |
| A11 | I/O<E> | D1 | I/O<G> | F19 | I/O<D> | L16 | I/O<C> | R14 | V _{CC} | V4 | I/O<A> |
| A12 | I/O<E> | D2 | I/O<G> | G1 | I/O<G> | L17 | V _{CCIO<C>} | R15 | GND | V5 | I/O<A> |
| A13 | I/O<E> | D3 | I/O<F> | G2 | I/O<G> | L18 | I/O<C> | R16 | I/O<C> | V6 | IOCTRL<A> |
| A14 | IOCTRL<E> | D4 | I/O<F> | G3 | IOCTRL<G> | L19 | I/O<C> | R17 | V _{CCIO<C>} | V7 | I/O<A> |
| A15 | I/O<E> | D5 | I/O<F> | G4 | I/O<G> | M1 | I/O<H> | R18 | I/O<C> | V8 | I/O<A> |
| A16 | I/O<E> | D6 | I/O<F> | G5 | V _{CC} | M2 | I/O<H> | R19 | I/O<C> | V9 | I/O<A> |
| A17 | I/O<E> | D7 | I/O<F> | G15 | V _{CC} | M3 | I/O<H> | T1 | I/O<H> | V10 | CLK<1> |
| A18 | PLLRS<1> | D8 | I/O<F> | G16 | I/O<D> | M4 | I/O<H> | T2 | I/O<H> | V11 | CLK<4>/DEDCLK/PLLIN<0> |
| A19 | GND | D9 | CLK<8> | G17 | I/O<D> | M5 | V _{CC} | T3 | I/O<A> | V12 | I/O |
| B1 | PLLRS<0> | D10 | I/O<E> | G18 | I/O<D> | M15 | V _{CC} | T4 | I/O<A> | V13 | I/O |
| B2 | GND | D11 | I/O<E> | G19 | I/O<D> | M16 | INREF<C> | T5 | I/O<A> | V14 | INREF |
| B3 | I/O<F> | D12 | I/O<E> | H1 | I/O<G> | M17 | I/O<C> | T6 | IOCTRL<A> | V15 | I/O |
| B4 | I/O<F> | D13 | INREF<E> | H2 | I/O<G> | M18 | I/O<C> | T7 | I/O<A> | V16 | I/O |
| B5 | I/O<F> | D14 | I/O<E> | H3 | I/O<G> | M19 | I/O<C> | T8 | I/O<A> | V17 | I/O |
| B6 | INREF<F> | D15 | I/O<E> | H4 | I/O<G> | N1 | IOCTRL<H> | T9 | I/O<A> | V18 | GNDPLL<2> |
| B7 | I/O<F> | D16 | I/O<D> | H5 | V _{CC} | N2 | I/O<H> | T10 | I/O<A> | V19 | GND |
| B8 | I/O<F> | D17 | I/O<D> | H15 | V _{CC} | N3 | I/O<H> | T11 | CLK<3>/PLLIN<1> | W1 | GND |
| B9 | TMS | D18 | I/O<D> | H16 | V _{CC} | N4 | I/O<H> | T12 | I/O | W2 | PLLRS<3> |
| B10 | CLK<6> | D19 | I/O<D> | H17 | I/O<D> | N5 | V _{CC} | T13 | I/O | W3 | I/O<A> |
| B11 | I/O<E> | E1 | I/O<G> | H18 | I/O<D> | N15 | V _{CC} | T14 | I/O | W4 | I/O<A> |
| B12 | I/O<E> | E2 | I/O<G> | H19 | I/O<D> | N16 | I/O<C> | T15 | I/O | W5 | I/O<A> |
| B13 | IOCTRL<E> | E3 | V _{CCIO<G>} | J1 | I/O<G> | N17 | I/O<C> | T16 | I/O | W6 | I/O<A> |
| B14 | I/O<E> | E4 | I/O<F> | J2 | I/O<G> | N18 | IOCTRL<C> | T17 | V _{CCPLL<2>} | W7 | I/O<A> |
| B15 | I/O<E> | E5 | GND | J3 | V _{CCIO<G>} | N19 | IOCTRL<C> | T18 | I/O | W8 | I/O<A> |
| B16 | I/O<E> | E6 | V _{CC} | J4 | I/O<G> | P1 | I/O<H> | T19 | I/O | W9 | TDI |
| B17 | V _{CCPLL<1>} | E7 | V _{CC} | J5 | GND | P2 | I/O<H> | U1 | I/O<A> | W10 | CLK<2>/PLLIN<2> |
| B18 | GNDPLL<1> | E8 | V _{CC} | J15 | V _{CC} | P3 | IOCTRL<H> | U2 | I/O<A> | W11 | I/O |
| B19 | PLLOUT<0> | E9 | V _{CC} | J16 | I/O<C> | P4 | INREF<H> | U3 | V _{CCPLL<3>} | W12 | I/O |
| C1 | I/O<F> | E10 | GND | J17 | V _{CCIO<D>} | P5 | V _{CC} | U4 | I/O<A> | W13 | I/O |
| C2 | V _{CCPLL<0>} | E11 | GND | J18 | I/O<D> | P15 | GND | U5 | V _{CCIO<A>} | W14 | IOCTRL |
| C3 | I/O<F> | E12 | V _{CC} | J19 | I/O<D> | P16 | I/O<C> | U6 | INREF<A> | W15 | I/O |
| C4 | I/O<F> | E13 | V _{CC} | K1 | V _{CC} | P17 | I/O<C> | U7 | I/O<A> | W16 | I/O |
| C5 | V _{CCIO<F>} | E14 | GND | K2 | TCK | P18 | I/O<C> | U8 | I/O<A> | W17 | I/O |
| C6 | IOCTRL<F> | E15 | GND | K3 | I/O<G> | P19 | I/O<C> | U9 | V _{CCIO<A>} | W18 | I/O |
| C7 | I/O<F> | E16 | I/O<D> | K4 | I/O<G> | R1 | I/O<H> | U10 | CLK<0> | W19 | PLLOUT<1> |
| C8 | I/O<F> | E17 | V _{CCIO<D>} | K5 | GND | R2 | I/O<H> | U11 | V _{CCIO} | | |
| C9 | V _{CCIO<F>} | E18 | INREF<D> | K15 | GND | R3 | V _{CCIO<H>} | U12 | I/O | | |

280 PBGA Packaging Drawing

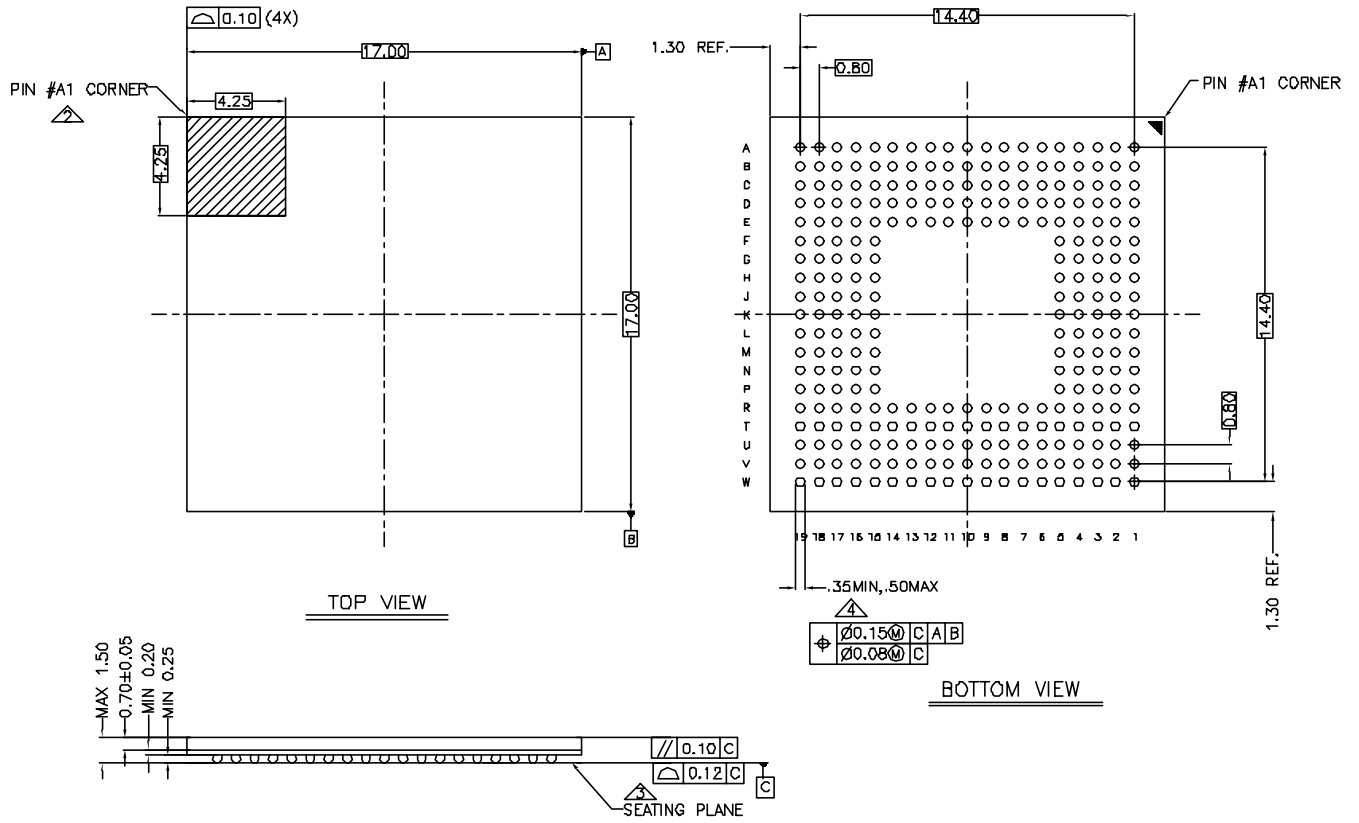
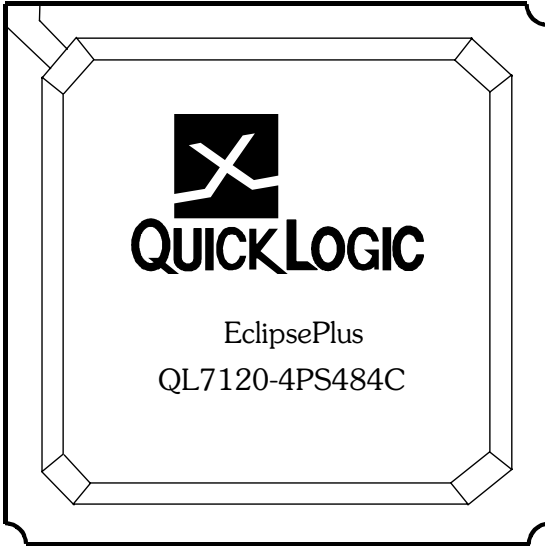


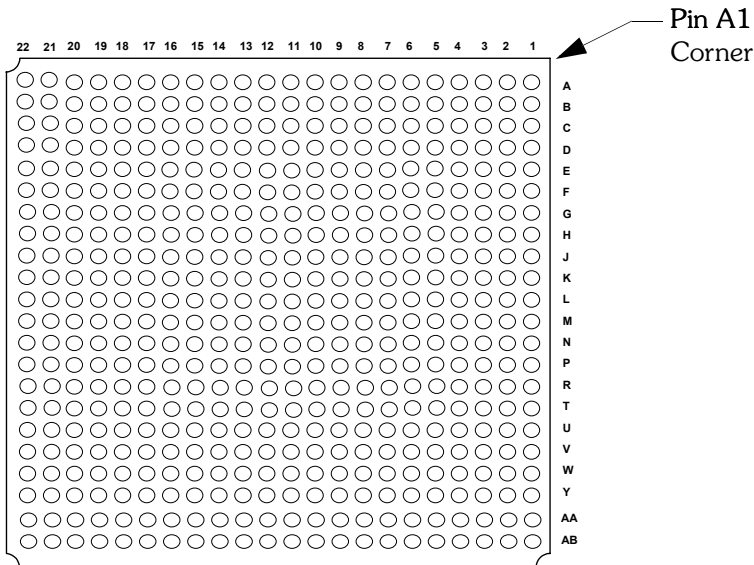
Figure 27: 280 PBGA Packaging Drawing

484 PBGA Pinout Diagram

Top



Bottom



484 PBGA Pinout Table

Table 25: 484 PBGA Pinout Table

| PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function |
|------|-----------|------|------------------------|------|-----------------------|------|-----------------------|------|-----------------------|------|---------------------------|
| A1 | I/O<A> | C1 | I/O<A> | E1 | IOCTRL<A> | G1 | I/O<A> | J1 | I/O<A> | L1 | CLK<4> DEDCLK/PLLIN<0> |
| A2 | PLLRST<3> | C2 | I/O<A> | E2 | I/O<A> | G2 | I/O<A> | J2 | I/O<A> | L2 | CLK<0> |
| A3 | I/O<A> | C3 | V _{CCPLL} <3> | E3 | I/O<A> | G3 | I/O<A> | J3 | I/O<A> | L3 | CLK<2>/PLLIN<2> |
| A4 | I/O<A> | C4 | PLLOUT<2> | E4 | I/O<A> | G4 | I/O<A> | J4 | I/O<A> | L4 | I/O<A> |
| A5 | I/O<A> | C5 | I/O<A> | E5 | I/O<A> | G5 | I/O<A> | J5 | I/O<A> | L5 | I/O<A> |
| A6 | I/O<H> | C6 | I/O<H> | E6 | I/O<H> | G6 | I/O<A> | J6 | I/O<A> | L6 | I/O<A> |
| A7 | I/O<H> | C7 | I/O<H> | E7 | N/C | G7 | GND | J7 | I/O<A> | L7 | GND |
| A8 | IOCTRL<H> | C8 | I/O<H> | E8 | I/O<H> | G8 | I/O<H> | J8 | V _{CC} | L8 | GND |
| A9 | I/O<H> | C9 | IOCTRL<H> | E9 | I/O<H> | G9 | I/O<H> | J9 | GND | L9 | GND |
| A10 | N/C | C10 | I/O<H> | E10 | I/O<H> | G10 | I/O<H> | J10 | V _{CC} | L10 | GND |
| A11 | N/C | C11 | I/O<H> | E11 | V _{CC} | G11 | I/O<G> | J11 | V _{CC} | L11 | GND |
| A12 | TCK | C12 | I/O<H> | E12 | I/O<G> | G12 | GND | J12 | GND | L12 | GND |
| A13 | I/O<G> | C13 | I/O<G> | E13 | I/O<G> | G13 | I/O<G> | J13 | V _{CC} | L13 | GND |
| A14 | I/O<G> | C14 | I/O<G> | E14 | I/O<G> | G14 | I/O<G> | J14 | GND | L14 | V _{CC} |
| A15 | I/O<G> | C15 | I/O<G> | E15 | IOCTRL<G> | G15 | I/O<G> | J15 | V _{CC} | L15 | V _{CC} |
| A16 | I/O<G> | C16 | I/O<G> | E16 | I/O<G> | G16 | GND | J16 | I/O<F> | L16 | CLK<6> |
| A17 | I/O<G> | C17 | I/O<G> | E17 | INREF<G> | G17 | V _{CCIO} <F> | J17 | V _{CCIO} <F> | L17 | V _{CCIO} <F> |
| A18 | I/O<G> | C18 | I/O<G> | E18 | I/O<G> | G18 | I/O<F> | J18 | I/O<F> | L18 | I/O<F> |
| A19 | I/O<F> | C19 | I/O<F> | E19 | I/O<F> | G19 | I/O<F> | J19 | I/O<F> | L19 | CLK<8> |
| A20 | GND | C20 | GNDPLL<0> | E20 | I/O<F> | G20 | I/O<F> | J20 | I/O<F> | L20 | I/O<F> |
| A21 | PLLOUT<3> | C21 | I/O<F> | E21 | I/O<F> | G21 | INREF<F> | J21 | I/O<F> | L21 | I/O<F> |
| A22 | I/O<F> | C22 | I/O<F> | E22 | I/O<F> | G22 | I/O<F> | J22 | I/O<F> | L22 | I/O<F> |
| B1 | I/O<A> | D1 | I/O<A> | F1 | I/O<A> | H1 | I/O<A> | K1 | TDI | M1 | I/O |
| B2 | GND | D2 | I/O<A> | F2 | INREF<A> | H2 | I/O<A> | K2 | I/O<A> | M2 | I/O |
| B3 | GNDPLL<3> | D3 | I/O<A> | F3 | I/O<A> | H3 | I/O<A> | K3 | I/O<A> | M3 | I/O |
| B4 | GND | D4 | I/O<A> | F4 | I/O<A> | H4 | I/O<A> | K4 | I/O<A> | M4 | CLK<3>/PLLIN<1> |
| B5 | I/O<A> | D5 | I/O<A> | F5 | I/O<A> | H5 | IOCTRL<A> | K5 | I/O<A> | M5 | I/O |
| B6 | I/O<H> | D6 | I/O<H> | F6 | V _{CCIO} <A> | H6 | V _{CCIO} <A> | K6 | V _{CCIO} <A> | M6 | V _{CCIO} |
| B7 | I/O<H> | D7 | I/O<H> | F7 | V _{CCIO} <H> | H7 | I/O<H> | K7 | I/O<A> | M7 | CLK<1> |
| B8 | INREF<H> | D8 | I/O<H> | F8 | I/O<H> | H8 | GND | K8 | V _{CC} | M8 | V _{CC} |
| B9 | I/O<H> | D9 | I/O<H> | F9 | V _{CCIO} <H> | H9 | V _{CC} | K9 | V _{CC} | M9 | V _{CC} |
| B10 | I/O<H> | D10 | I/O<H> | F10 | I/O<H> | H10 | V _{CC} | K10 | GND | M10 | GND |
| B11 | I/O<H> | D11 | I/O<H> | F11 | V _{CCIO} <H> | H11 | V _{CC} | K11 | GND | M11 | GND |
| B12 | N/C | D12 | I/O<G> | F12 | V _{CCIO} <G> | H12 | GND | K12 | GND | M12 | GND |
| B13 | N/C | D13 | I/O<G> | F13 | I/O<G> | H13 | V _{CC} | K13 | GND | M13 | GND |
| B14 | N/C | D14 | I/O<G> | F14 | V _{CCIO} <G> | H14 | V _{CC} | K14 | V _{CC} | M14 | GND |
| B15 | I/O<G> | D15 | IOCTRL<G> | F15 | N/C | H15 | GND | K15 | V _{CC} | M15 | GND |
| B16 | I/O<G> | D16 | I/O<G> | F16 | V _{CCIO} <G> | H16 | I/O<F> | K16 | I/O<F> | M16 | GND |
| B17 | I/O<G> | D17 | I/O<G> | F17 | N/C | H17 | I/O<F> | K17 | I/O<F> | M17 | I/O<E> |
| B18 | I/O<G> | D18 | I/O<F> | F18 | I/O<F> | H18 | I/O<F> | K18 | I/O<F> | M18 | I/O<E> |
| B19 | PLLRST<0> | D19 | V _{CCPLL} <0> | F19 | I/O<F> | H19 | I/O<F> | K19 | I/O<F> | M19 | I/O<E> |
| B20 | I/O<F> | D20 | I/O<F> | F20 | IOCTRL<F> | H20 | I/O<F> | K20 | I/O<F> | M20 | CLK<7> |
| B21 | I/O<F> | D21 | I/O<F> | F21 | I/O<F> | H21 | I/O<F> | K21 | I/O<F> | M21 | CLK<5>/PLLIN<3> |
| B22 | I/O<F> | D22 | I/O<F> | F22 | IOCTRL<F> | H22 | I/O<F> | K22 | I/O<F> | M22 | TMS |

(Sheet 1 of 2)

Table 25: 484 PBGA Pinout Table (Continued)

| PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function | PBGA | Function |
|------|----------------------------|------|----------------------------|------|----------------------------|------|-----------------|------|-----------------------------|------|-----------------------------|
| N1 | I/O | P16 | I/O<E> | T9 | N/C | V2 | I/O | W17 | I/O<D> | AA10 | I/O<C> |
| N2 | I/O | P17 | I/O<E> | T10 | TRSTB | V3 | I/O | W18 | I/O<E> | AA11 | I/O<C> |
| N3 | I/O | P18 | I/O<E> | T11 | GND | V4 | I/O | W19 | I/O<E> | AA12 | I/O<D> |
| N4 | I/O | P19 | I/O<E> | T12 | N/C | V5 | I/O | W20 | I/O<E> | AA13 | I/O<D> |
| N5 | I/O | P20 | I/O<E> | T13 | I/O<D> | V6 | I/O<C> | W21 | I/O<E> | AA14 | I/O<D> |
| N6 | I/O | P21 | I/O<E> | T14 | N/C | V7 | I/O<C> | W22 | I/O<E> | AA15 | I/O<D> |
| N7 | I/O | P22 | I/O<E> | T15 | I/O<D> | V8 | I/O<C> | Y1 | I/O | AA16 | I/O<D> |
| N8 | V _{CC} | R1 | I/O | T16 | GND | V9 | N/C | Y2 | I/O | AA17 | I/O<D> |
| N9 | V _{CC} | R2 | INREF | T17 | I/O<E> | V10 | I/O<C> | Y3 | V _{CCPLL<2>} | AA18 | I/O<D> |
| N10 | GND | R3 | I/O | T18 | I/O<E> | V11 | I/O<C> | Y4 | I/O<C> | AA19 | I/O<E> |
| N11 | GND | R4 | I/O | T19 | I/O<E> | V12 | V _{CC} | Y5 | I/O<C> | AA20 | GNDPLL<1> |
| N12 | GND | R5 | I/O | T20 | I/O<E> | V13 | N/C | Y6 | I/O<C> | AA21 | I/O<E> |
| N13 | GND | R6 | I/O | T21 | IOCTRL<E> | V14 | I/O<D> | Y7 | I/O<C> | AA22 | I/O<E> |
| N14 | V _{CC} | R7 | I/O | T22 | I/O<E> | V15 | I/O<D> | Y8 | IOCTRL<C> | AB1 | I/O |
| N15 | V _{CC} | R8 | GND | U1 | IOCTRL | V16 | INREF<D> | Y9 | I/O<C> | AB2 | GNDPLL<2> |
| N16 | I/O<E> | R9 | V _{CC} | U2 | I/O | V17 | I/O<D> | Y10 | I/O<C> | AB3 | PLLST<2> |
| N17 | V _{CCIO<E>} | R10 | V _{CC} | U3 | IOCTRL | V18 | I/O<E> | Y11 | I/O<D> | AB4 | I/O |
| N18 | I/O<E> | R11 | GND | U4 | I/O | V19 | I/O<E> | Y12 | I/O<D> | AB5 | I/O |
| N19 | I/O<E> | R12 | V _{CC} | U5 | I/O | V20 | I/O<E> | Y13 | I/O<D> | AB6 | I/O<C> |
| N20 | I/O<E> | R13 | V _{CC} | U6 | I/O<C> | V21 | I/O<E> | Y14 | I/O<D> | AB7 | I/O<C> |
| N21 | I/O<E> | R14 | V _{CC} | U7 | V _{CCIO<C>} | V22 | I/O<E> | Y15 | IOCTRL<D> | AB8 | IOCTRL<C> |
| N22 | I/O<E> | R15 | GND | U8 | N/C | W1 | I/O | Y16 | I/O<D> | AB9 | I/O<C> |
| P1 | I/O | R16 | I/O<D> | U9 | V _{CCIO<C>} | W2 | I/O | Y17 | I/O<D> | AB10 | I/O<C> |
| P2 | I/O | R17 | V _{CCIO<E>} | U10 | I/O<C> | W3 | I/O | Y18 | I/O<E> | AB11 | I/O<C> |
| P3 | I/O | R18 | I/O<E> | U11 | V _{CCIO<C>} | W4 | I/O | Y19 | PLLOUT<0> | AB12 | I/O<D> |
| P4 | I/O | R19 | I/O<E> | U12 | V _{CCIO<D>} | W5 | I/O | Y20 | PLLST<1> | AB13 | I/O<D> |
| P5 | I/O | R20 | I/O<E> | U13 | I/O<D> | W6 | I/O<C> | Y21 | I/O<E> | AB14 | I/O<D> |
| P6 | V _{CCIO} | R21 | I/O<E> | U14 | V _{CCIO<D>} | W7 | N/C | Y22 | I/O<E> | AB15 | I/O<D> |
| P7 | I/O | R22 | I/O<E> | U15 | N/C | W8 | I/O<C> | AA1 | TDO | AB16 | IOCTRL<D> |
| P8 | V _{CC} | T1 | I/O | U16 | V _{CCIO<D>} | W9 | I/O<C> | AA2 | PLLOUT<1> | AB17 | I/O<D> |
| P9 | GND | T2 | I/O | U17 | V _{CCIO<E>} | W10 | I/O<C> | AA3 | GND | AB18 | I/O<D> |
| P10 | V _{CC} | T3 | I/O | U18 | I/O<E> | W11 | I/O<C> | AA4 | I/O | AB19 | I/O<E> |
| P11 | GND | T4 | I/O | U19 | I/O<E> | W12 | I/O<D> | AA5 | I/O<C> | AB20 | GND |
| P12 | V _{CC} | T5 | I/O | U20 | IOCTRL<E> | W13 | I/O<D> | AA6 | I/O<C> | AB21 | V _{CCPLL<1>} |
| P13 | V _{CC} | T6 | V _{CCIO} | U21 | I/O<E> | W14 | I/O<D> | AA7 | I/O<C> | AB22 | I/O<E> |
| P14 | GND | T7 | GND | U22 | INREF<E> | W15 | I/O<D> | AA8 | INREF<C> | | |
| P15 | V _{CC} | T8 | I/O<C> | V1 | I/O | W16 | N/C | AA9 | I/O<C> | | |

(Sheet 2 of 2)

484 PBGA Packaging Drawing

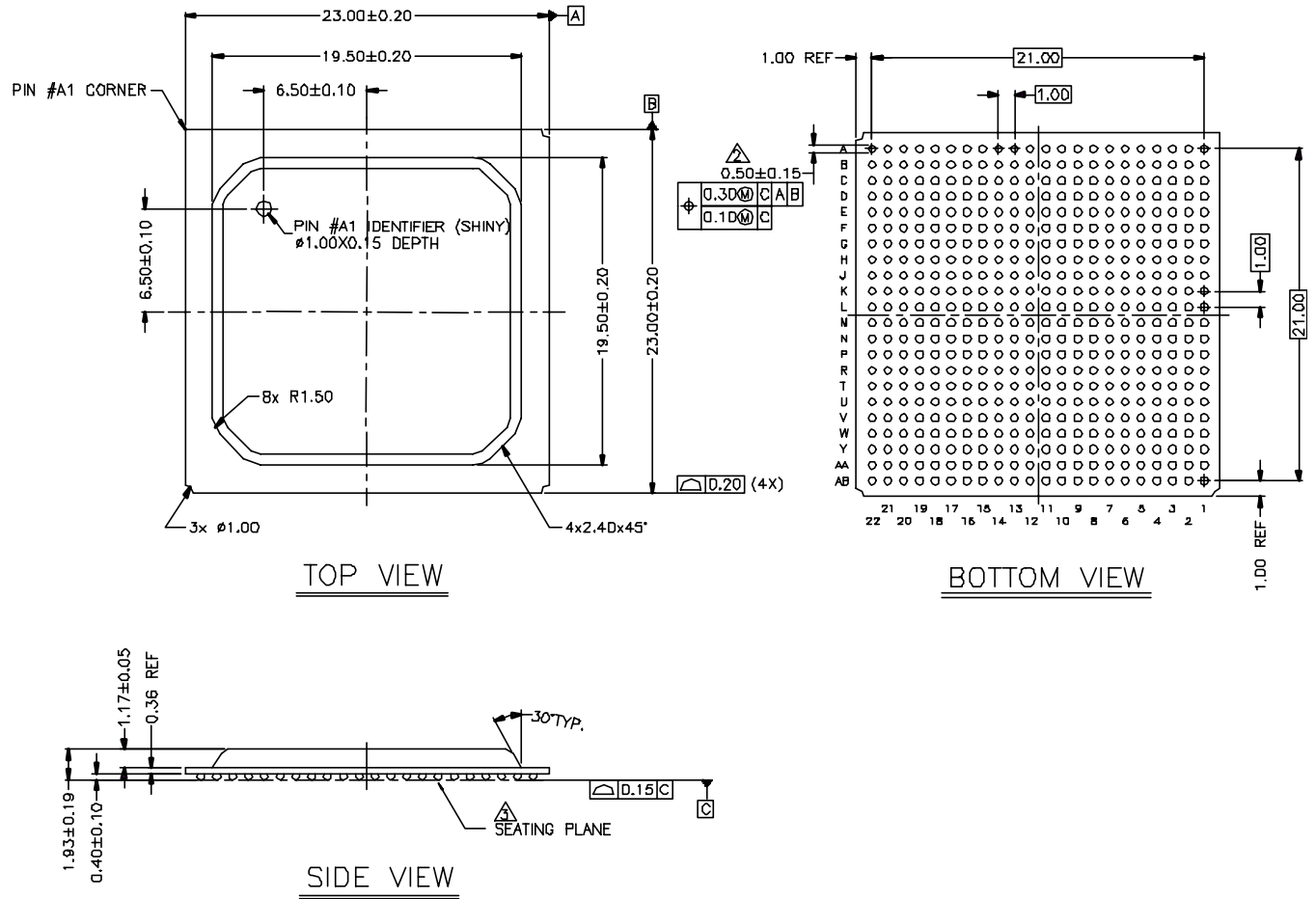


Figure 28: 484 PBGA Packaging Drawing

Ordering Information

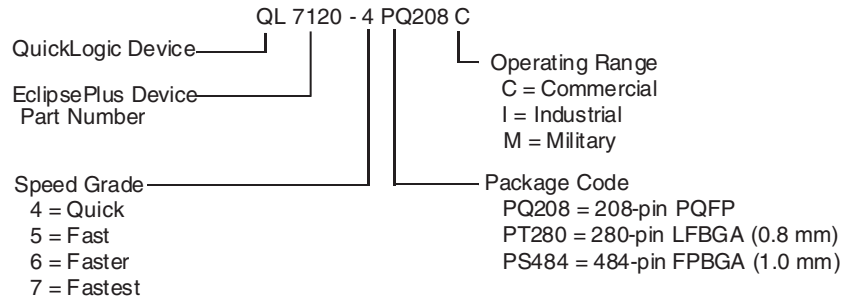


Figure 29: Ordering Information

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Revision History

Table 26: Revision History

| Revision | Date | Comments |
|----------|------------|---|
| A | Aug 2002 | Brian Faith, Judd Heape, Andreea Rotaru, Paul Micallef |
| B | April 2003 | Brian Faith, Kathleen Murchek Incorporated comments, added PLL section, removed 516 pinout diagram, table, and pkg. dwg. |
| C | May 2003 | Brian Faith, Kathleen Murchek |

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